Service Manual

Telephone Equipment

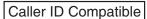
Model No. KX-TG7622B

KX-TG7623B

KX-TGA410B

Link-to-Cell Cellular Convergence Solution

B: Black Version (for U.S.A.)











KX-TGA410B (Handset)

(X-TG7621B (Base Unit)



(Charger Unit)

Configuration for each model

Model No	Base Unit	Handset	Charger Unit	Expandable
KX-TG7622	1 (TG7621)	2 (TGA410)	1	Up to 6
KX-TG7623	1 (TG7621)	3 (TGA410)	2	Up to 6
KX-TGA410*		1 (TGA410)	1	

^{*}KX-TGA410 is also an optional accessory, which contains a handset and a charger.

Information for optional accessories

You can expand your phone system by registering optional handsets (KX-TGA660) to a single base unit.

Optional handsets and the supplied handset are different model so that some functions may not be available.

Refer to each Operating Instruction for details.



⚠ WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

- IMPORTANT SAFETY NOTICE

There are special components used in this equipment which are important for safety. These parts are marked by \triangle in the Schematic Diagrams, Circuit Board Diagrams, Exploded Views and Replacement Parts List. It is essential that these critical parts should be replaced with manufacturer's specified parts to prevent shock, fire or other hazards. Do not modify the original design without permission of manufacturer.

IMPORTANT INFORMATION ABOUT LEAD FREE, (PbF), SOLDERING .

If lead free solder was used in the manufacture of this product, the printed circuit boards will be marked PbF. Standard leaded, (Pb), solder can be used as usual on boards without the PbF mark. When this mark does appear, please read and follow the special instructions described in this manual on the use of PbF and how it might be permissible to use Pb solder during service and repair work.

- When you note the serial number, write down all 11 digits. The serial number may be found on the bottom of the unit.
- The illustrations in this Service Manual may vary slightly from the actual product.

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1 Safety Precautions

1.1. For Service Technicians

- Repair service shall be provided in accordance with repair technology information such as service manual so as to prevent fires, injury or electric shock, which can be caused by improper repair work.
 - 1. When repair services are provided, neither the products nor their parts or members shall be remodeled.
 - 2. If a lead wire assembly is supplied as a repair part, the lead wire assembly shall be replaced.
 - 3. FASTON terminals shall be plugged straight in and unplugged straight out.
- ICs and LSIs are vulnerable to static electricity.

When repairing, the following precautions will help prevent recurring malfunctions.

- 1. Cover plastic parts boxes with aluminum foil.
- 2. Ground the soldering irons.
- 3. Use a conductive mat on worktable.
- 4. Do not grasp IC or LSI pins with bare fingers.

2 Warning

2.1. Battery Caution

Risk of explosion if battery is replaced by an incorrect type. Dispose of used batteries according to the instructions.

2.2. About Lead Free Solder (PbF: Pb free)

Note:

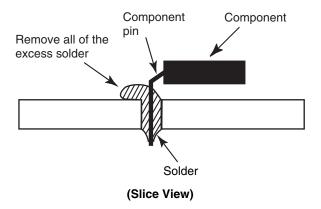
In the information below, Pb, the symbol for lead in the periodic table of elements, will refer to standard solder or solder that contains lead.

We will use PbF solder when discussing the lead free solder used in our manufacturing process which is made from Tin (Sn), Silver (Ag), and Copper (Cu).

This model, and others like it, manufactured using lead free solder will have PbF stamped on the PCB. For service and repair work we suggest using the same type of solder.

Caution

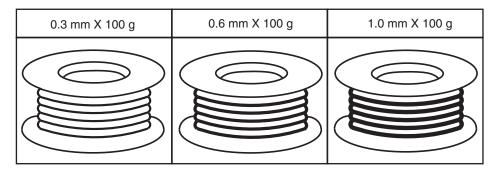
- PbF solder has a melting point that is 50 °F ~ 70 °F (30 °C ~ 40 °C) higher than Pb solder. Please use a soldering iron with temperature control and adjust it to 700 °F ± 20 °F (370 °C ± 10 °C).
- Exercise care while using higher temperature soldering irons.:
 - Do not heat the PCB for too long time in order to prevent solder splash or damage to the PCB.
- PbF solder will tend to splash if it is heated much higher than its melting point, approximately 1100 °F (600 °C).
- When applying PbF solder to double layered boards, please check the component side for excess which may flow onto the opposite side (See the figure below).



2.2.1. Suggested PbF Solder

There are several types of PbF solder available commercially. While this product is manufactured using Tin, Silver, and Copper (Sn+Ag+Cu), you can also use Tin and Copper (Sn+Cu), or Tin, Zinc, and Bismuth (Sn+Zn+Bi). Please check the manufacturer's specific instructions for the melting points of their products and any precautions for using their product with other materials.

The following lead free (PbF) solder wire sizes are recommended for service of this product: 0.3 mm, 0.6 mm and 1.0 mm.



2.3. Discarding of P. C. Board

When discarding P. C. Board, delete all personal information such as telephone directory and caller list or scrap P. C. Board.

3 Specifications

■ Standard:

DECT 6.0 (Digital Enhanced Cordless Telecommunications 6.0)

Bluetooth wireless technology 2.0

■ Number of channels:

60 Duplex Channels (DECT 6.0) 79 Duplex channels(Bluetooth)

■ Frequency range:

1.92 GHz to 1.93 GHz (DECT 6.0) 2.402 GHz to 2.48 GHz (Bluetooth)

■ Duplex procedure:

TDMA (Time Division Multiple Access)

■ Channel spacing:

- 1.728MHz (DECT 6.0)
- 1.0MHz(Bluetooth)

■ Bit rate:

1.152Mbit/s (DECT 6.0) 1.0 Mbit/s (Bluetooth)

■ Modulation:

GFSK (Gaussian Frequency Shift Keying)

■ RF transmission power:

115 mW (max/DECT6.0)

■ Voice coding:

ADPCM 32 kbit/s (DECT 6.0) CVSD/PCM 64kbit/s (Bluetooth) PCM 64kbit/s(BT_IC)

	Base Unit	Handset	Charger
Power source	AC Adaptor	Rechargeable Ni-MH battery	AC Adaptor
	(PNLV226Z, 120 V AC, 60 Hz)	AAA (R03) size (1.2 V 550 mAh)	(PNLV226Z, 120 V AC, 60 Hz)
Receiving Method	Super Heterodyne	Super Heterodyne	
Oscillation Method	PLL synthesizer	PLL synthesizer	
Detecting Method	Quadrature Discriminator	Quadrature Discriminator	
Tolerance of OSC Frequency	10.368 MHz ±100 Hz	13.824 MHz ±100 Hz	
Modulation Method	Frequency Modulation	Frequency Modulation	
ID Code	40 bit	40 bit	
Ringer Equivalence No. (REN)	0.1B		
Dialing Mode	Tone (DTMF)/Pulse	Tone (DTMF)/Pulse	
Redial	Up to 48 digits	Up to 48 digits	
Speed Dialer	——	Up to 24 digits (Phonebook)	
Power Consumption	Standby: Approx. 1.5 W	11 days at Standby,	Standby: Approx 0.1 W
	Maximum: Approx. 4.8 W	13 hours at Talk	Maximum: Approx 2.0 W
Operating Conditions	0 °C - 40 °C (32 °F – 104 °F)	0 °C - 40 °C (32 °F – 104 °F)	0 °C - 40 °C (32 °F – 104 °F)
	20 % – 80 % relative air humidity	20 % – 80 % relative air humidity	20 % – 80 % relative air humidity
	(dry)	(dry)	(dry)
Dimensions (H x W x D)	Approx. 90 mm × 151 mm × 96 mm	Approx. 159 mm×49 mm×29 mm	Approx. 43 mm \times 73 mm \times 76 mm
Mass (Weight)	Approx. 210 g	Approx. 130 g	Approx. 50 g

Note:

• Design and specifications are subject to change without notice.

Note for Service:

• Operation range: Up to 300 m outdoors, Up to 50 m indoors, depending on the condition.

- · Analog telephone connection: Telephone Line
- Optional Range extender: KX-TGA405

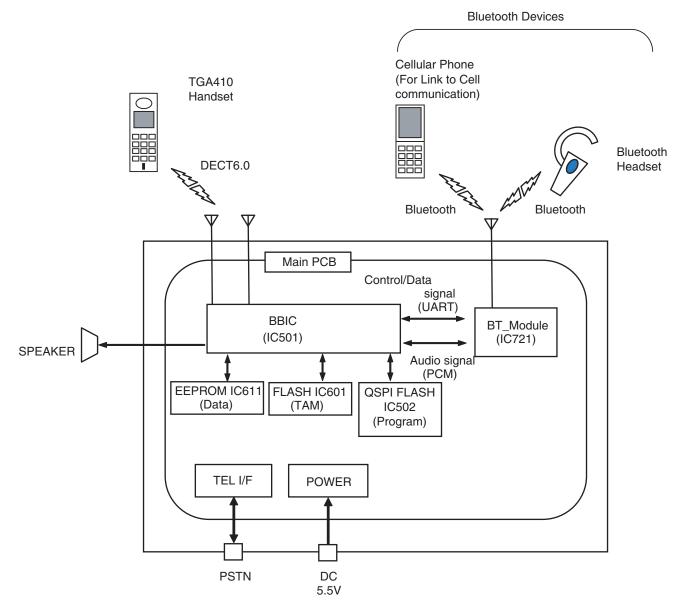
4 Technical Descriptions

4.1. Circuit Configuration of TG762x Series Phones

TG762x consists of DECT cordless telephone and Bluetooth Module.

Both voices of transmission and reception are transferred by PCM.

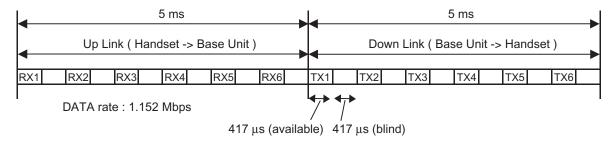
BBIC on DECT side controls the cordless telephone system, which makes control data communication with BT_IC on BT Module in serial data.



4.2. US-DECT Description

The frequency range of 1.92 GHz-1.93 GHz is used. Transmitting and receiving carrier between base unit and handset is same frequency. Refer to **Frequency Table** (P.65).

4.2.1. TDD Frame Format

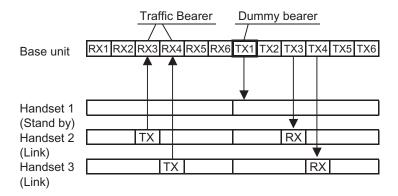


4.2.2. TDMA system

This system is the cycles of 10 ms, and has 6 duplex paths, but maximum duplex communication path is 5 because of dummy bearer use.

In 1 slot 417 μ s, the 10 ms of voice data is transmitted.

• 2 - Handsets Link



Traffic Bearer

A link is established between base unit and handset.

The state where duplex communication is performed.

Handset doesn't make up duplex in no free RF channels because of interference. (*1)

Dummy Bearer

Base unit sends Dummy-data to the all stand-by state handsets.

Handsets receive that data for synchronization and monitoring request from the base unit.

Base unit doesn't send Dummy bearer in no free RF channels because of interference. (*1)

Note:

(*1) It is a feature under FCC 15 regulation and for interference avoidance.

In the case of checking RF parts, it is better in least interference condition.

4.2.3. Signal Flowchart in the Radio Parts

Reception

Base unit:

A voice signal from TEL line is encoded to digital data and converted into a 1.9GHz modulated radio signal by BBIC(IC501). The RF signal, after which is amplified in BBIC, is fed to selected antenna.

Handset:

As for a handset RF, RF signal is received in one antenna.

BBIC down-converts to 864 kHz IF signal from RX signal and demodulates it to digital data "RXDATA".

BBIC (IC1) converts RXDATA into a voice signal and outputs it to speaker.

Transmission

Handset:

A voice signal from microphone is encoded to digital data and converted into a 1.9GHz modulated radio signal by BBIC(IC1). The RF signal, after which is amplified in BBIC, is fed to an antenna.

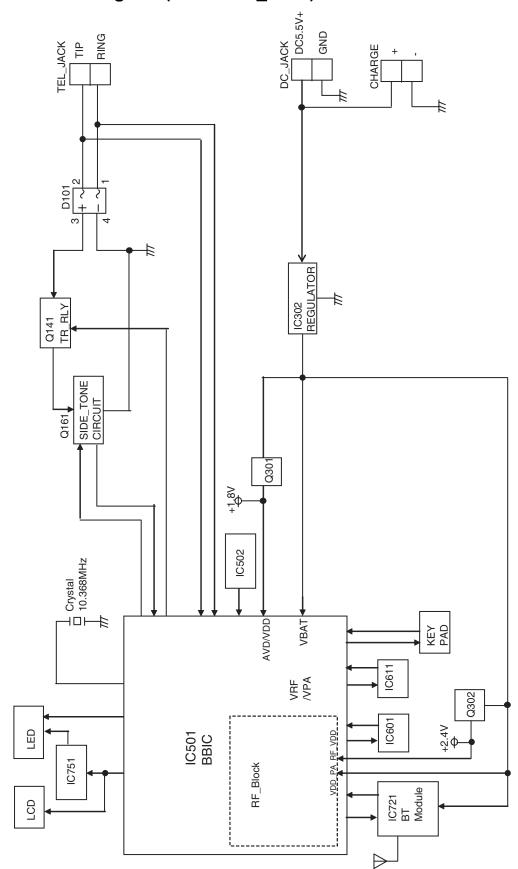
Base unit:

As for a base unit RF, RF signal is received in two antennas.

BBIC (IC501) compares RF signal levels and selects the antenna to be used. Then BBIC down-converts to 864 kHz IF signal from RX signal in the selected antenna, and demodulates it to digital data "RXDATA".

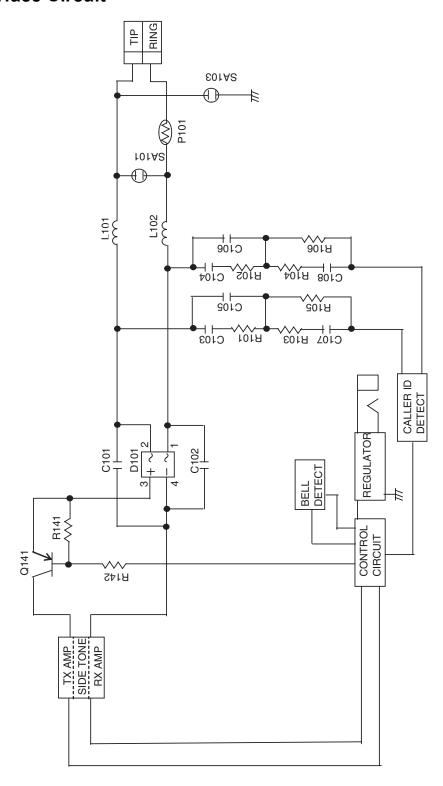
BBIC (IC501) converts RXDATA into a voice signal and outputs it to TEL line.

4.3. Block Diagram (Base Unit_Main)

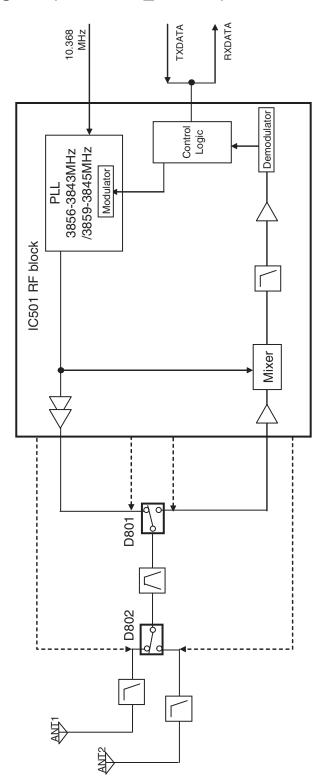


KX-TG7622/7623 BLOCK DIAGRAM (Base Unit_Main)

4.4. Tel Interface Circuit



KX-TG7622B/KX-TG7623B/KX-TGA410B 4.5. Block Diagram (Base Unit_RF Part)



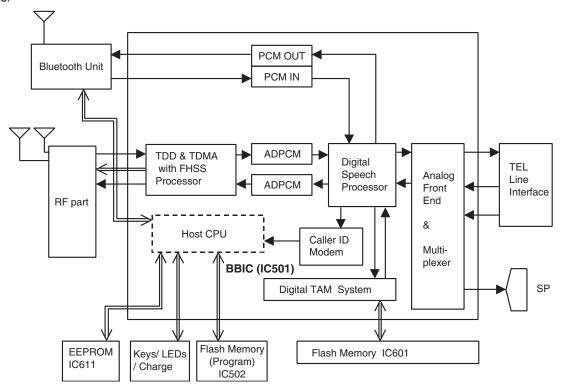
KX-TG7622/7623 BLOCK DIAGRAM (Base Unit_RF Part)

4.6. Circuit Operation (Base Unit)

General Description:

(BBIC, Flash Memory, EERROM) is a digital speech/signal processing system that implements all the functions of speech compression, record and playback, and memory management required in a digital telephone answering machine.

The BBIC system is fully controlled by a host processor. The host processor provides activation and control of all that functions as follows.



4.6.1. BBIC (Base Band IC: IC501)

Voice Message Recording/Play back

The BBIC system uses a proprietary speech compression technique to record and store voice message in Flash Memory. An error correction algorithm is used to enable playback of these messages from the Flash Memory.

DTMF Generator

When the DTMF data from the handset is received, the DTMF signal is output.

Synthesized Voice (Pre-recorded message)

The BBIC implements synthesized Voice, utilizing the built in speech detector and a Flash Memory, which stored the vocabulary.

Caller ID demodulation

The BBIC implements monitor and demodulate the FSK/DTMF signals that provide CID information from the Central Office.

· Digital Switching

The voice signal from telephone line is transmitted to the handset or the voice signal from the handset is transmitted to the Telephone line, etc. They are determined by the signal path route operation of voice signal.

Block Interface Circuit

RF part, LED, Key scan, Speaker, Telephone line.

4.6.2. Flash Memory (IC502)

Main program data is stored.

4.6.3. Flash Memory (IC601)

Following information data is stored.

Voice signal

ex: Pre-recorded Greeting message, Incoming message

4.6.4. **EEPROM** (IC611)

Following information data is stored.

Settings

ex: message numbers, ID code, Flash Time, Tone/Pulse

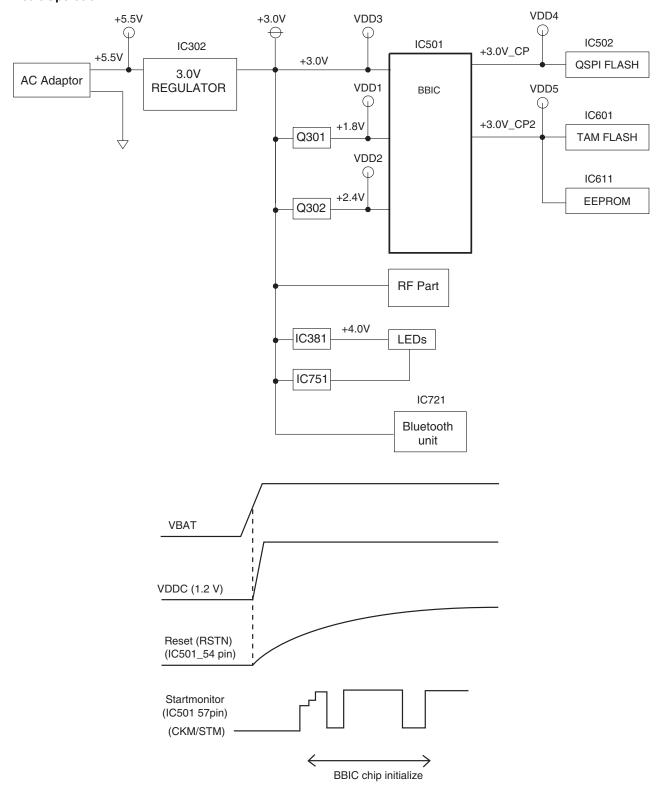
4.6.5. Bluetooth Unit (IC721)

Use for Bluetooth communication.

4.6.6. Power Supply Circuit/Reset Circuit

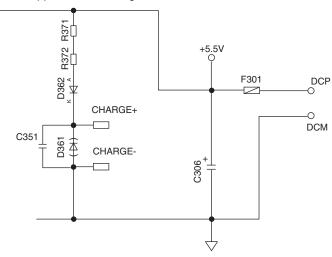
The power supply voltage from AC adaptor is converted to VBAT (3.0V) in IC302. And +3.0V for peripherals and analog part is insulated from VBAT by Doubler of BBIC.

Circuit Operation:



4.6.6.1. Charge Circuit

The voltage from the AC adaptor is supplied to the charge circuits.



4.6.7. Telephone Line Interface

Telephone Line Interface Circuit:

Function

- · Bell signal detection
- · ON/OFF hook and pulse dial circuit
- · Side tone circuit

Bell (RINGING) signal detection and OFF HOOK circuit:

In the idle mode, Q141 is open to cut the DC loop current and decrease the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

 $L1T\rightarrow L101\rightarrow C105\rightarrow R105\rightarrow R110\rightarrow R111\rightarrow R112\rightarrow BBIC\ pin18(RINGING)$

When the CPU (BBIC) detects a ring signal, Q141 turns on, thus providing an off-hook condition (active DC current flow through the circuit). Following signal flow is the DC current flow.

 $\mathsf{T} \to \mathsf{L}101 \to \mathsf{D}101 \to \mathsf{Q}141 \to \mathsf{Q}161 \to \mathsf{R}163 \to \mathsf{R}167 \to \mathsf{D}101 \to \mathsf{L}102 \to \mathsf{P}101 \to \mathsf{R}$

ON HOOK Circuit:

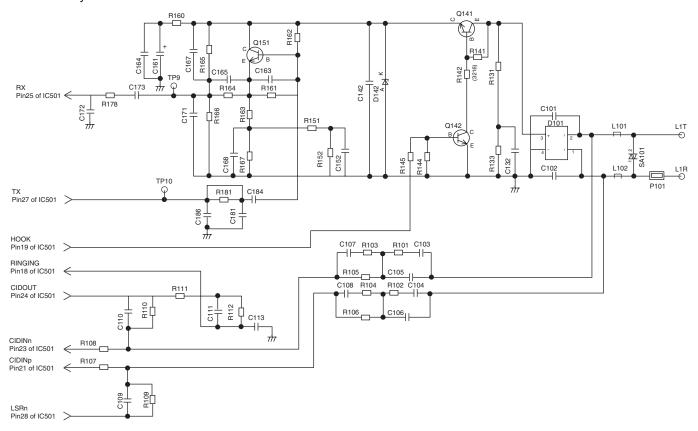
Q141 is open, Q141 is connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in an on-hook condition.

Pulse Dial Circuit:

Pin 19 of BBIC turns Q141 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal. As for this unit, TX signal feed back from Q161 is cancelled by the canceller circuit of BBIC.



4.6.8. Parallel Connection Detect Circuit/Auto Disconnect Circuit

Function:

In order to disable call waiting and stutter tone functions when using telephones connected in parallel, it is necessary to have a circuit that judges whether a telephone connected in parallel is in use or not. This circuit determines whether the telephone connected in parallel is on hook or off hook by detecting changes in the T/R voltage.

Circuit Operation:

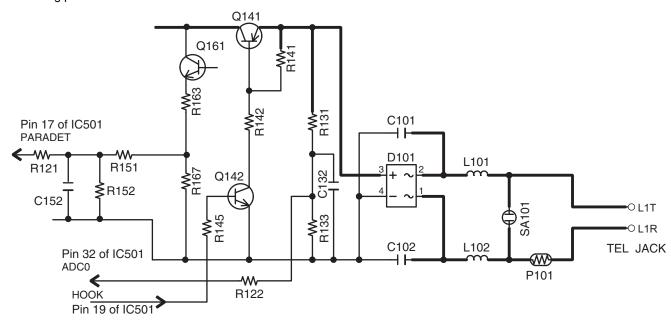
Parallel connection detection when on hook:

When on hook, the voltage is monitored at pin 32 of IC501. There is no parallel connection if the voltage is 0.54 V or higher, while a parallel connection is deemed to exist if the voltage is lower.

Parallel connection detection when off hook:

When off hook, the voltage is monitored at pin 17 of IC501; the presence/absence of a parallel connection is determined by detecting the voltage changes.

If the Auto disconnect function is ON and statuses are Hold, receiving ICM, OGM transmitting, BBIC disconnects the line after detecting parallel connection is off hook.



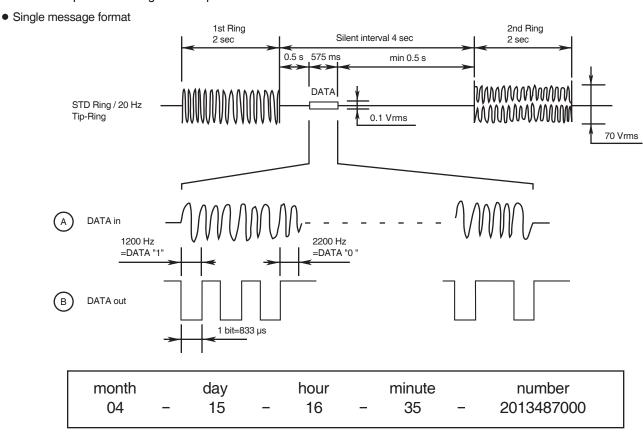
4.6.9. Calling Line Identification (Caller ID)/Call Waiting Caller ID

Function:

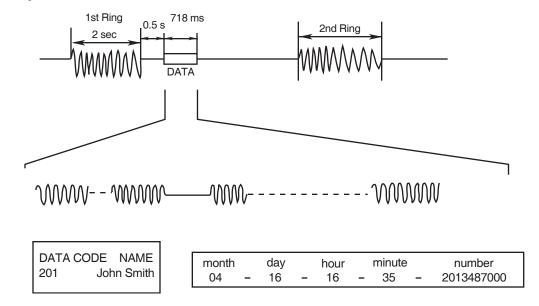
Caller ID

The caller ID is a chargeable ID which the user of a telephone circuit obtains by entering a contract with the telephone company to utilize a caller ID service. For this reason, the operation of this circuit assumes that a caller ID service contract has been entered for the circuit being used. The data for the caller ID from the telephone exchange is sent during the interval between the first and second rings of the bell signal. The data from the telephone exchange is a modem signal which is modulated in an FSK (Frequency Shift Keying) * format. Data "1" is a 1200 Hz sine wave, and data "0" is a 2200 Hz sine wave. There are two types of the message format which can be received: i.e. the single message format and plural message format. The plural message format allows to transmit the name and data code information in addition to the time and telephone number data.

*: Also the telephone exchange service provides other formats.



Plural message format



Call Waiting Caller ID

Calling Identity Delivery on Call Waiting (CIDCW) is a CLASS service that allows a customer, while off-hook on an existing call, to receive information about a calling party on a waited call. The transmission of the calling information takes place almost immediately after the customer is alerted to the new call so he/she can use this information to decide whether to take the new call.

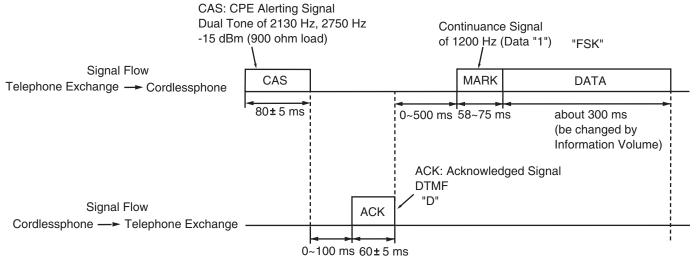
Function:

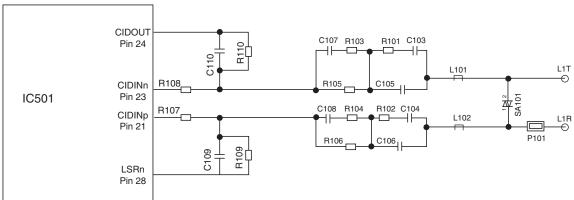
The telephone exchange transmits or receives CAS and ACK signals through each voice RX/TX route. Then FSK data and MARK data pass the following route.

Telephone Line→P101→L101, L102→C105, C106→R105, R106→R108, R107→IC501(23, 21).

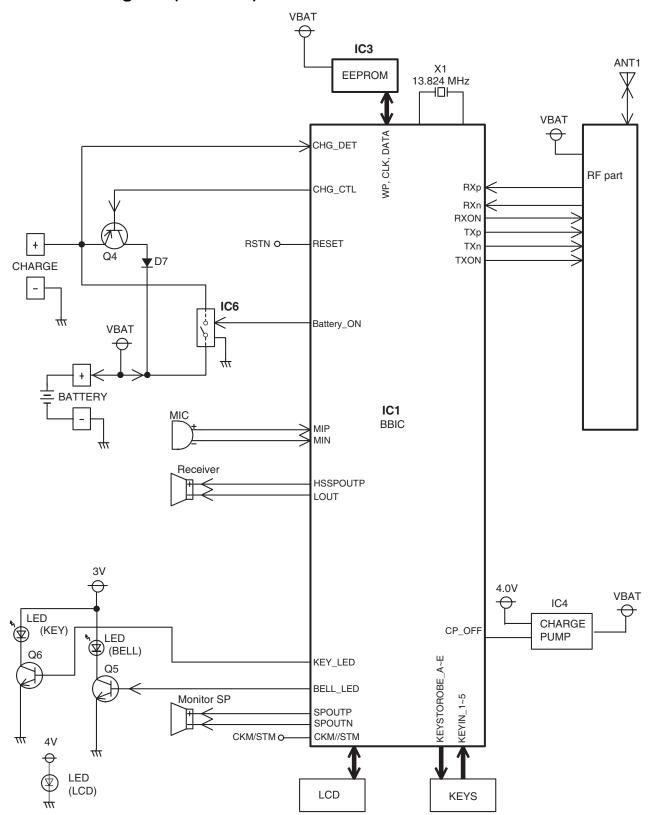
If the unit deems that a telephone connected in parallel is in use, ACK is not returned even if CAS is received, and the information for the second and subsequent callers is not displayed on the portable handset display.

Call Waiting Format



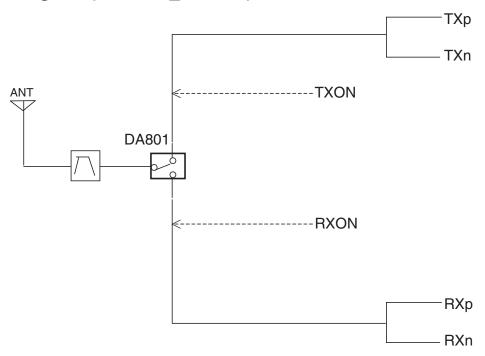


4.7. Block Diagram (Handset)



KX-TGA410 BLOCK DIAGRAM (Handset)

4.8. Block Diagram (Handset_RF Part)



KX-TGA410 BLOCK DIAGRAM (Handset_RF Part)

4.9. Circuit Operation (Handset)

4.9.1. **Outline**

Handset consists of the following ICs as shown in Block Diagram (Handset) (P.20).

- DECT BBIC (Base Band IC): IC1
 - All data signals (forming/analyzing ACK or CMD signal)
 - All interfaces (ex: Key, Detector Circuit, Charge, EEPROM, LCD)
- EEPROM: IC3
 - Setting data is stored. (e.g. ID, user setting)

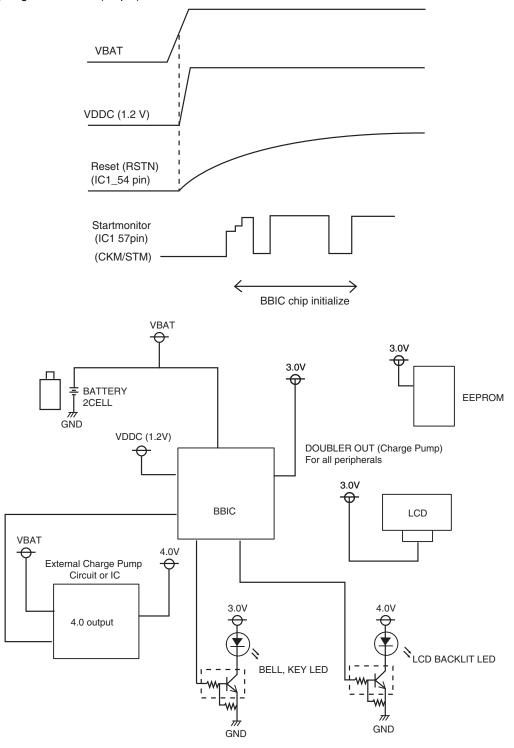
4.9.2. Power Supply Circuit/Reset Circuit

Circuit Operation:

When power on the Handset, the voltage is as follows;

BATTERY(2.2 V ~ 2.6 V: BATT+) \rightarrow F1 \rightarrow BBC1 (IC1) 10 pin

The Reset signal generates IC1 (54 pin) and 1.8 V.



4.9.3. Charge Circuit

Circuit Operation:

When charging the handset on the Base Unit, the charge current is as follows;

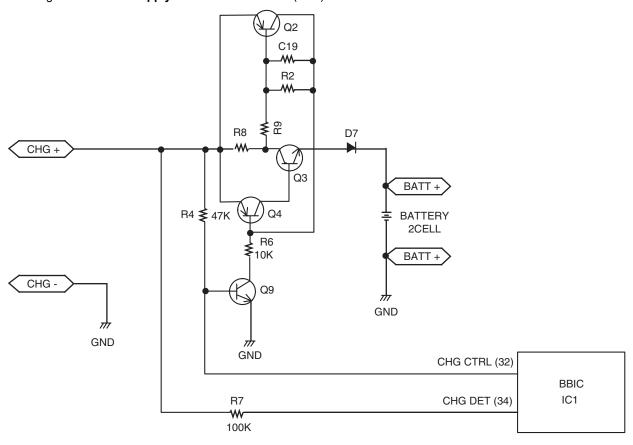
 $\mathsf{DC+}(6.5\ \mathsf{V}) \to \mathsf{F301} \to \mathsf{R371} \to \mathsf{R372} \to \mathsf{CHARGE+}(\mathsf{Base}) \to \mathsf{CHARGE+}(\mathsf{Handset}) \to \mathsf{Q4} \to \mathsf{D7} \to \mathsf{F1} \to \mathsf{BATTERY+}...\ \mathsf{Battery}...$

 $BATTERY- \rightarrow R45 \rightarrow GND \rightarrow CHARGE-(Handset) \rightarrow CHARGE-(Base) \rightarrow GND \rightarrow DC-(GND)$

In this way, the BBIC on Handset detects the fact that the battery is charged.

The charge current is controlled by switching Q9 of Handset.

Refer to Fig.101 in Power Supply Circuit/Reset Circuit (P.14).



4.9.4. Battery Low/Power Down Detector

Circuit Operation:

"Battery Low" and "Power Down" are detected by BBIC which check the voltage from battery.

The detected voltage is as follows;

· Battery Low

Battery voltage: V(Batt) ≤ 2.35 V ± 50 mV

The BBIC detects this level and " starts flashing.

• Power Down

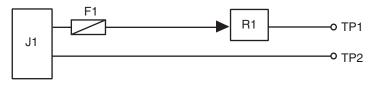
Battery voltage: V(Batt) ≤ 2.1 V ± 50 mV The BBIC detects this level and power down.

4.9.5. Speakerphone

The hands-free loudspeaker at SP+ and SP- is used to generate the ring alarm.

4.10. Circuit Operation (Charger Unit)

Charge control is executed at handset side so that the operation when using charger is also controlled by handset. Refer to **Circuit Operation (Handset)** (P.22)



AC Adaptor

The route for this is as follows: DC+pin of J1(+) \rightarrow F1 \rightarrow R1 \rightarrow CHARGE+pad \rightarrow Handset \rightarrow CHARGE-pad \rightarrow DC-pin of J1(-).

4.11. Signal Route

SIGNAL ROUTE	IN \rightarrow ROUTE \rightarrow	OUT
	LIANDOST MIO. DZOIZA. O44/40. DAA. IO4/00/00)	
HANDSET TX ——	H HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23) <handset_rf_tx_route></handset_rf_tx_route> - ANT	
	ANT <base_unit_rf_rx_route></base_unit_rf_rx_route> - IC501(2/3 - 27) - C184 - Q161 -Q141	
	- D101 - L101/[L102-P101] - T/R (TEL LINE)	
HANDSET RX —	T/R (TEL LINE) - L101/[P101-L102] - D101 - Q141 - R165 - C173 - R178	
TIXINDOET TIX	- IC501(25 - 94/95) - <base_unit_rf_tx_route></base_unit_rf_tx_route> - ANT	
	ANT <handset_rf_rx_route></handset_rf_rx_route> - IC1(28/27) - C86 - L74 -	
	HEADSET_JACK(5 - 4) - R11 - HANDSET SPEAKER	
HANDSET ———	HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23)	
SP-Phone TX	- <handset_rf_tx_route> - ANT</handset_rf_tx_route>	
	ANT <base_unit_rf_rx_route></base_unit_rf_rx_route> - IC501(2/3 - 27) - C184 - Q161 -Q141 - D101 - L101/[L102-P101] - T/R (TEL LINE)	
	- DIOI - LIOI/[LIO2-FIOI] - I/N (TEL LINE)	
HANDSET	T/R (TEL LINE) - L101/[P101-L102] - D101 - Q141 - R165 - C173 - R178	
SP-Phone RX	- IC501(25 - 94/95) - <base_unit_rf_tx_route></base_unit_rf_tx_route> - ANT ANT. -<handset_rf_rx_route></handset_rf_rx_route> - IC1(29/31) - Backside SP	
	ANT< HANDSET_RF_RX_ROUTE> - ICT(29/31) - Backside SP	
CELLULAR TX —	HANDSET MIC - R73/74 - C11/13 - RA4 -IC1(22/23)	
OLLLOLANTIA	- <handset_rf_tx_route> - ANT</handset_rf_tx_route>	
	ANT <base_unit_rf_rx_route></base_unit_rf_rx_route> - IC501(2/3 - 80)	
	- IC721(31 - 19) - R781 - ANT_BT - CELL PHONE	
CELLULAR RX —	CELL PHONE - ANT_BT - R781 - IC721(19 - 3) - IC501(81 - 94/95)	
	- <base_unit_rf_tx_route> - ANT</base_unit_rf_tx_route>	
	ANT < HANDSET_RF_RX_ROUTE> - IC1(28/27)	
	- C86 - L74 - HEADSET JACK(5-4) - R11- HANDSET SPEAKER	
	from BT Headset - ANT_BT - R781 - IC721(19 - 3) - IC501(81 - 27) - C184 - Q161 -Q141 - D101 - L101/[L102-P101] - T/R (TEL LINE)	
Headset Sound TX(to Tel Line)	- 0184 - Q161 -Q141 - D101 - E101/[E102-P101] - 1/R (TEE LINE)	
- Acto For Emo)		
	T/R (TEL LINE) - L101/[P101-L102] - D101 - Q141 - R165 - C173 - R178	
Headset Sound RX(from Tel Line)	- IC501(25 - 80) - IC721(31 - 19) - R781 - ANT_BT - to BT Headset	
TIX(IIOIII Tel LIIIe)		

Note:

: inside of Handset

RF part signal route

SIGNAL ROUTE	IN \rightarrow ROUTE \rightarrow OUT
INTERCOM ————————————————————————————————————	HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23) - <handset_rf_tx_route> - ANT ANT - <base_unit_rf_rx_route> - IC501(2/3 - 41/43) - SPEAKER</base_unit_rf_rx_route></handset_rf_tx_route>
INTERCOM————BASE UNIT TO HANDSET	MIC - C457/C458 - RA452 - IC501(37/38 - 94/95) - <base_unit_rf_tx_route></base_unit_rf_tx_route> - ANT ANT <handset_rf_rx_route></handset_rf_rx_route> - IC1(28/27) - C86 - L74 - HEADSET_JACK(5 - 4) - R11 - HANDSET SPEAKER
GREETING ————————————————————————————————————	HANDSET MIC - R73/74 - C11/13 - RA4 - IC1(22/23) - <handset_rf_tx_route> - ANT ANT - <base_unit_rf_rx_route> - IC501(2/3 - 69/70) - IC601</base_unit_rf_rx_route></handset_rf_tx_route>
GREETING PLAY— TO TEL LINE	_ IC601 - IC501(69/70 - 27) - C184 - Q161 -Q141- D101 - L101/[L102-P101] - T/R (TEL LINE)
ICM RECORDING -	T/R (TEL LINE) - L101/[P101-L102] - D101 - Q141 - R165 - C173 - R178 - IC501(25 - 69/70) - IC601
ICM PLAY TO————————————————————————————————————	→ IC601 - IC501(69/70 - 41/43) - SPEAKER
DTMF SIGNAL TO TEL LINE	IC501(27) - C184 - Q161 -Q141- D101 - L101/[L102-P101] - T/R (TEL LINE)
CALLER ID —	T/R(TEL LINE) - L101/[P101 - L102] - C105/C106 - R105/R106 - R108/R107 -IC501(23/21)
BELL DETECTION-	T/R(TEL LINE) - L101 - C105 - R105 - R110 - R111 - R112 - IC501(18)
HANDSET RF [TX_ROUTE]	IC1(44/45) - L809 - C812 - DA801 - C895 - ANT
HANDSET RF [RX_ROUTE]	ANT - C895 - DA801 - C826 - IC1(46/47)
BASE UNIT RF [TX_ROUTE]	IC501(95/94) - L802/C813 - C812 - DA801 - C803 - DA802 - C851/C853 - ANT1/ANT2
BASE UNIT RF [RX_ROUTE]	ANT1/ANT2 - C851/C853 - DA802 - C803 - DA801 - C826 - C854/C853 - IC501(3/2)

Note:

: inside of Handset

5 Location of Controls and Components

Refer to the Operating Instructions.

Note:

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

6 Installation Instructions

Refer to the Operating Instructions.

Note

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

7 Operating Instructions

Refer to the Operating Instructions.

Note

You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

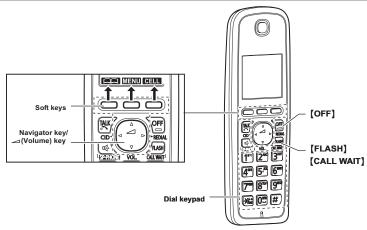
8 Test Mode

8.1. Engineering Mode

8.1.1. Base Unit

Important:

Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



H/S key operation

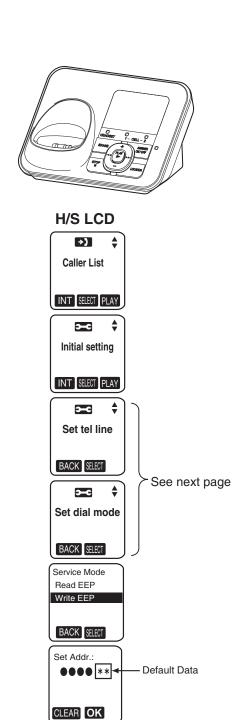
- 1). Press MENU.
- 2). Select "Initial Setting" using [▲]or[▼] then press ∰EET or [►].

Select "Set tel line" using [▲]or[▼] then press SECT or [►].

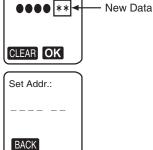
- 3). Enter "7", "2", "6", "2", "7", "6", "6", "4".

 Note: 7262 7664 = PANA SONI

 (see letters printed on dial keys)
- 4). Select "Write EEP" using [▲]or[▼] then press SEET or [►].
- 5). Enter "●", "●", "●", "●" (Address). (*1)
- 6). Enter "*", "*" (New Data). (*1)



7). Press **OK** , a long confirmation beep will be heard.



KX-TG7622B/KX-TG7623B/KX-TGA410B

Set Addr.:

8). Press [OFF] to return to standby mode.

After that, turn the base unit power off and then power on.

* "Set tel line" isn't appeared at Cell line only mode.

To back normal mode, execute the following procedure:

- 1 $[MENU] \rightarrow [\#][1][5][7]$
- 2 [V]/[A]: Select "off" \longrightarrow [SELECT]
- 3 [OFF]

Frequently Used Items (Base Unit)

ex.)

Items	Address	Default Data	New	Data	Remarks
Frequency	00 07 / 00 08	70/02	-	-	Use these items in a READ-ONLY mode to
ID	00 02 ~ 00 06	Given value	-	-	confirm the contents. Careless rewriting may
					cause serious damage to the computer system.

Note:

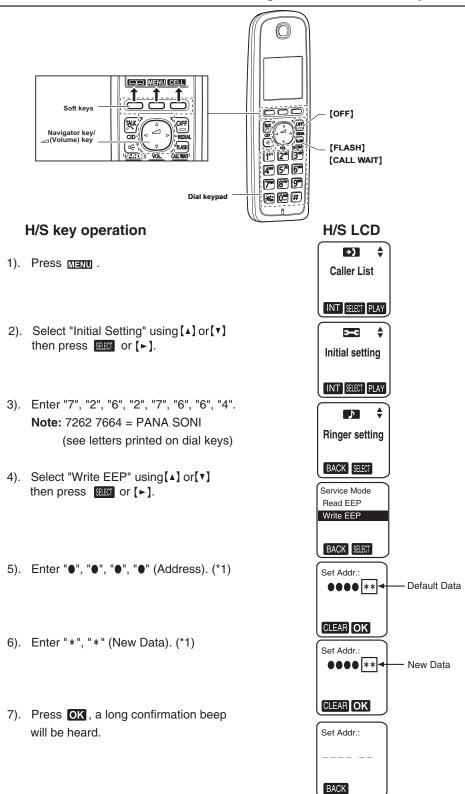
(*1) When you enter the address or New Data, please refer to the table below.

Desired Number (hex)	Input Keys	Desired Number (hex)	Input Keys
0	0	A	[Flash] + 0
1	1	В	[Flash] + 1
	-	С	[Flash] + 2
	-	D	[Flash] + 3
	-	E	[Flash] + 4
9	9	F	[Flash] + 5

8.1.2. Handset

Important:

Make sure the address on LCD is correct when entering new data. Otherwise, you may ruin the unit.



8). Press [OFF] to return to standby mode.

After that, remove and reinsert the batteries. Press the Power button for about 1 second if the power is not turned on.

Frequently Used Items (Handset)

ex.)

Items	Address	Default Data	New Data	Possible Adjusted Value MAX (hex)	Possible Adjusted Value MIN (hex)	Remarks
Battery Low	00 12/00 13	00 / 00	-	-	-	
Frequency	00 07 / 00 08	00 / 01	-	-	-	(*2)
ID	00 02 ~ 00 06	Given value	-	-	-	

Note:

(*1) When you enter the address or New Data, please refer to the table below.

Desired Number (hex.)	Input Keys	Desired Number (hex.)	Input Keys
0	0	A	[Flash] + 0
1	1	В	[Flash] + 1
-	-	С	[Flash] + 2
		D	[Flash] + 3
	-	E	[Flash] + 4
9	9	F	[Flash] + 5

^(*2) Use these items in a READ-ONLY mode to confirm the contents. Careless rewriting may cause serious damage to the handset.

KX-TG7622B/KX-TG7623B/KX-TGA410B

9 Service Mode

9.1. How to Clear User Setting (Handset Only)

Handset

Press [2,5,8], 0 simultaneously until a beep sound is heard. Then single handset is initialized.

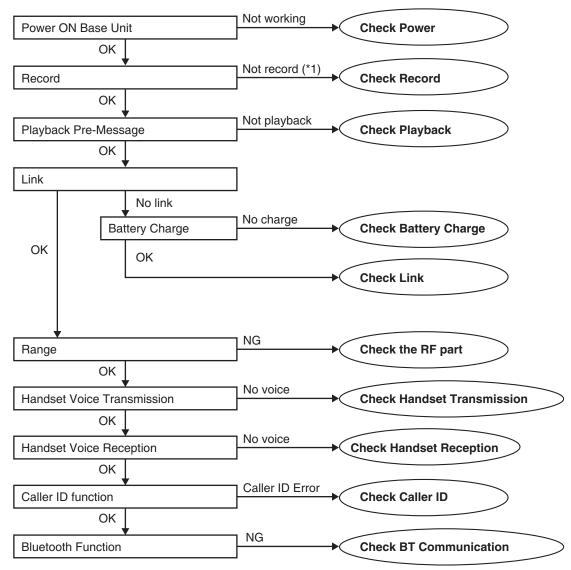
(The contents of user setting are reset to factory default)

*Usage time is not cleared.

10 Troubleshooting Guide

10.1. Troubleshooting Flowchart

FLOW CHART



Cross Reference:

Check Power (P.34)

Check Record (P.35)

Check Playback (P.38)

Check Battery Charge (P.38)

Check Link (P.39)

Check the RF part (P.41)

Check Handset Transmission (P.46)

Check Handset Reception (P.46)

Check Caller ID (P.46)

Check BT Communication (P.47)

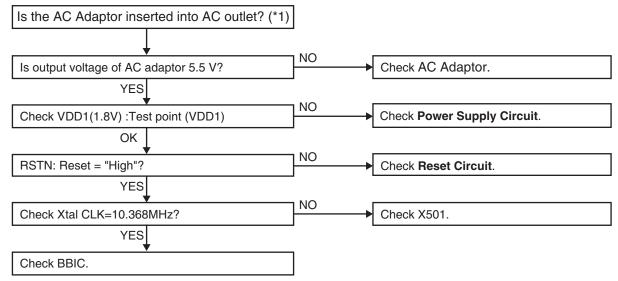
Note:

(*1) When a user claims that the unit disconnects a call right after the greeting message and no incoming messages can be recorded, this symptom can not be reappeared with TEL simulator in the service center. In this case, try to change the Auto disconnect activation time and Vox level.

<How to change the Auto Disconnect activation time and VOX level> (P.36) item (A) and (B).

10.1.1. Check Power

10.1.1.1. Base Unit



Cross Reference:

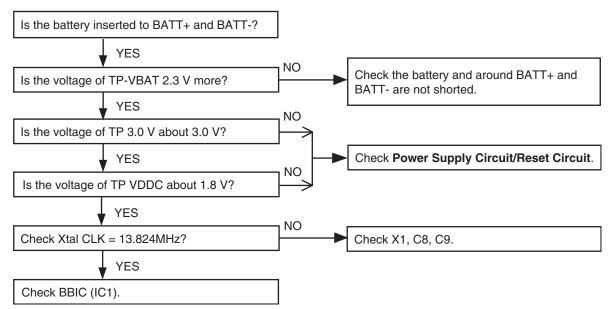
Power Supply Circuit/Reset Circuit (P.14)

Note:

BBIC is IC501.

- (*1) Refer to **Specifications** (P.6) for part number and supply voltage of AC adaptor.
- (*2) Refer to Circuit Board (Base Unit_Main) (P.81).

10.1.1.2. Handset



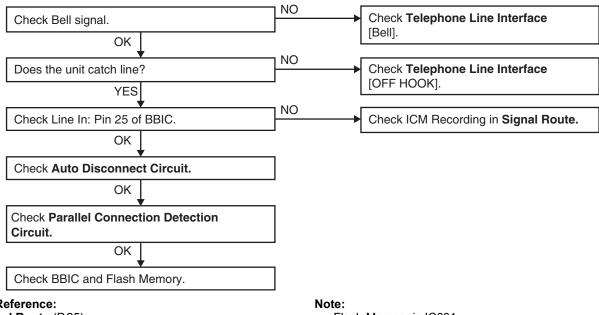
Cross Reference:

Power Supply Circuit/Reset Circuit (P.22)

10.1.2. Check Record

10.1.2.1. Base Unit

Not record Incoming Message



Cross Reference:

Signal Route (P.25)

Telephone Line Interface (P.16)

Parallel Connection Detect Circuit/Auto Disconnect

Circuit (P.17)

Flash Memory is IC601. BBIC is IC501.

<How to change the Auto Disconnect activation time and VOX level>

A) Auto Disconnect activation time:

Some Telephone Company lines (fiber or cable) ON Hook and OFF Hook voltages are lower than conventional lines, which may cause a malfunction of Auto Disconnect detection. To solve this problem, try changing the Auto Disconnect activation through the procedures below.

1) Press "MENU" key at standby Mode and "#" key.

Note: The set must power on and be linked.

2) Press "9", "0", "0", "0", "*".

LCD (H/S)



3) Press "7", "3", "1".

4) Then enter the below last digit;

last digit	"0"	Auto disconnect & CPC : enable • • • [default]
	"1"	Auto disconnect : enable ^(*1) CPC : disable
	"2"	Auto disconnect & CPC : disable (*2)

Note:

- (*1) Both Auto Disconnect and CPC don't detect for the first 2 seconds.
- (*2) If the "Disable" is selected, even if the parallel-connected telephone is OFF HOOK, the line isn't disconnected.
- 5) Back to "standby" mode automatically after step 4). You can hear beep sound which is a confirmation tone.

B) Vox level:

It makes easier to detect a small voice (caller) by raising the sensitivity of VOX level. Therefore, the recording of TAM is not turned off during a detection.

- 1) ~ 2) are same as (A).
- 3) Press "5","1","1".



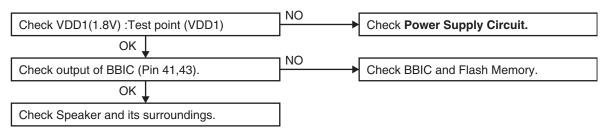
4) Then enter the below last digit;

last digit	"0"	default setting : normal
	"1"	6dB up

5) Back to "standby" mode automatically after step 4). You can hear beep sound which is a confirmation tone.

10.1.3. Check Playback

10.1.3.1. Base Unit



Cross Reference:

Power Supply Circuit/Reset Circuit (P.14)

Note:

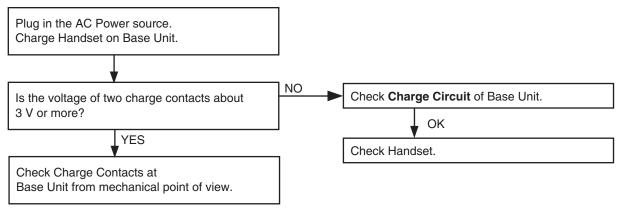
Flash Memory is IC601.

BBIC is IC1.

(*1) Refer to Circuit Board (Base Unit_Main) (P.81).

10.1.4. Check Battery Charge

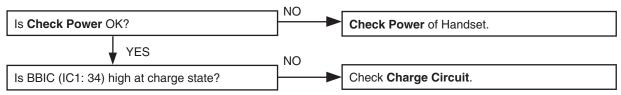
10.1.4.1. Base Unit



Cross Reference:

Charge Circuit (P.15)

10.1.4.2. Handset

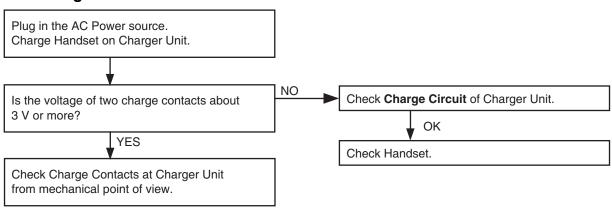


Cross Reference:

Check Power (P.34)

Charge Circuit (P.23)

10.1.4.3. Charger Unit

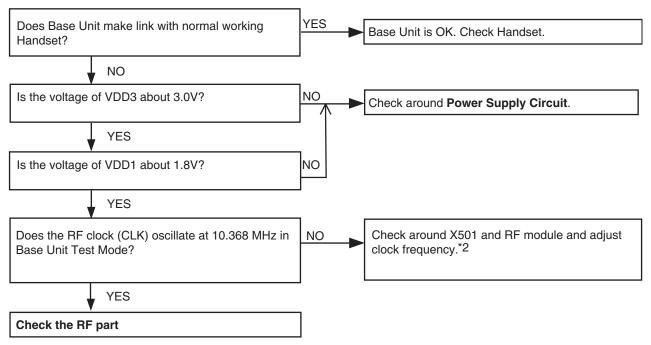


Cross Reference:

Charge Circuit (P.23)

10.1.5. Check Link

10.1.5.1. Base Unit



Cross Reference:

Power Supply Circuit/Reset Circuit (P.14)

Check the RF part (P.41)

Note:

*1 How to adjust +3.0V:

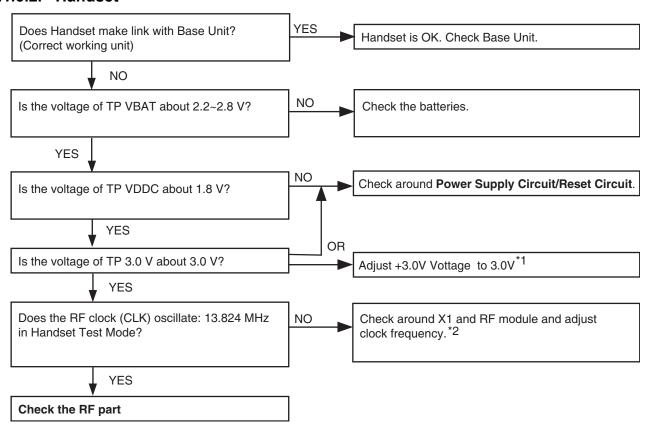
Execute the command "VDA"

Refer to Things to Do after Replacing IC or X'tal (P.63) for Base Unit.

*2 How to adjust the frequency of X501:

To see the frequency, execute the command "SFR", then check the TP_CKM (IC501-57pin).

10.1.5.2. Handset



Cross Reference:

Power Supply Circuit/Reset Circuit (P.22)

Check the RF part (P.41)

Note:

*1 How to adjust +3.0V:

Execute the command "VDA"

Refer to Things to Do after Replacing IC or X'tal (P.64) for Handset.

*2 How to adjust the frequency of X1:

To see the frequency, execute the command "SFR", then check the TP_CKM (IC1-57pin).

To adjust frequency, send command "SFR □○○□○○"until the frequency counter becomes13.824 MHz±55HZ.

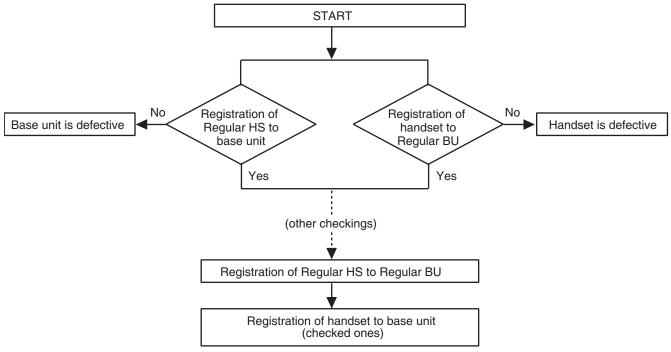
10.1.6. Check the RF part

10.1.6.1. Finding out the Defective part

- 1. Prepare Regular HS(*1) and Regular BU(*2).
- 2. a. Re-register regular HS (Normal mode) to base unit (to be checked). If this operation fails in some ways, the base unit is defective.
 - b. Re-register handset (to be checked) to regular BU (Normal mode). If this operation fails in some ways, the handset is defective.

After All the Checkings or Repairing

1. Re-register the checked handset to the checked base unit, and Regular HS to Regular BU.

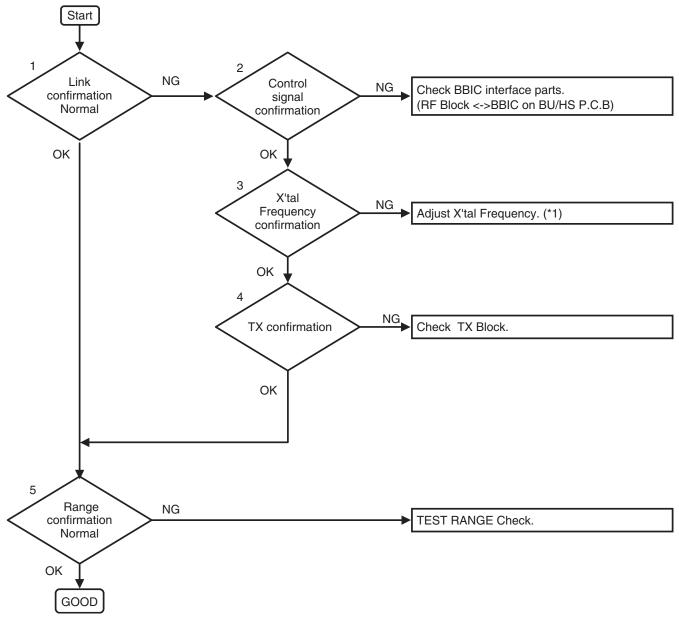


Note:

(*1) HS: Handset (*2) BU: Base Unit

10.1.6.2. RF Check Flowchart

Each item (1 \sim 5) of RF Check Flowchart corresponds to **Check Table for RF part** (P.43). Please refer to the each item.



Note:

(*1) Refer to Check Link (P.39).

10.1.6.3. Check Table for RF part

No.	Item	BU (Base Unit) Check HS (Handset) Check	
1	Link Confirmation Normal	Register Regular HS to BU (to be checked).	Register HS (to be checked) to Regular BU.
	HS, BU Mode [Normal Mode]	Press [Talk] key of the Regular HS to establish link. Press [Talk] key of the HS to establish link.	
2	X'tal Frequency confirmation	Check X'tal Frequency.	Check X'tal Frequency.
		(10.368 MHz ±100Hz)	(13.824 MHz ±100 Hz)
	HS, BU Mode: [Adjustment]		
3	TX confirmation	Remove wire antenna 2 and connect spectrum analyzer to TP. (*2).	Connect spectrum analyzer to TP.(*3) Confirm TX power whether satisfied spec.
	HS Mode:	Confirm TX power whether spec. is	Power >=16.0dBm
	HS_Burst Mode] (*1)	satisfied. Power >=12.5dBm	
	BS Mode:		
	BS_Burst Mode] (*1)		
4	Range Confirmation Normal	Register Regular HS to BU (to be checked).	Register HS (to be checked) to Regular BU.
	HS, BU Mode: [Normal Mode]	Press [Talk] key of the Regular HS to establish link.	Press [Talk] key of the HS to establish link. Compare the range of the HS (being)
		Compare the range of the BU (being checked) with that of the Regular BU.	checked) with that of the Regular HS.

Note:

- (*1) Refer to **Commands** (P.59)
- (*2) Adjustment Standard (Base Unit) (P.60)
- (*3) Adjustment Standard (Handset) (P.62)

10.1.6.4. TEST RANGE Check

Circuit block which range is defective can be found by the following check.

Item	BU (Base Unit) Check	HS (Handset) Check	
Range Confirmation TX TEST	Register Regular HS to BU (to be checked).	Register HS (to be checked) to Regular BU.	
(TX Power check)			
	2. Set TX Power of the BU and the Regular HS	Set TX Power of the HS and the Regular BU	
HS, BU setting	according to CHART1.	RT1. according to CHART1.	
Checked unit: Low TX power (*1)			
Regular unit: High TX power (*1)	3. At distance of about 20m between HS and BU,	3. At distance of about 20m between HS and BU,	
	Link $OK = TX$ Power of the BU is OK .	Link OK = TX Power of the HS is OK.	
	No Link = TX Power of the BU is NG.	No Link = TX Power of the HS is NG.	
Range Confirmation RX TEST	Register Regular HS to BU (to be checked).	Register HS (to be checked) to Regular BU.	
(RX sensitivity check)			
	Set TX Power of the BU and the Regular HS	2. Set TX Power of the Checking HS and the Reg-	
HS, BU setting	according to CHART1.	ular BU according to CHART1.	
Checked unit: High TX power (*1)			
Regular unit: Low TX power (*1)	3. At distance of about 20m between HS and BU,	3. At distance of about 20m between HS and BU,	
	Link OK= RX Sensitivity of the BU is OK.	Link OK= RX Sensitivity of the HS is OK.	
	No Link = RX Sensitivity of the BU is NG.	No Link = RX Sensitivity of the HS is NG	

CHART1: Setting of TX Power and RX Sensitivity in Range Confirmation TX TEST, RX TEST

	BU (to be checked)	Regular_HS	
	TX Power	TX Power	
BU (Base Unit) TX Power Check	Low	Hig h	
BU (Base Unit) RX Sensitivity Check	High	Low	

	HS (to be checked)	Regular_BU	
	TX Power	TX Power	
HS (Handset) TX Power Check	Low	High	
HS (Handset) RX Sensitivity Check	High	Low	

Note:

(*1) Refer to Commands (P.59).

10.1.7. Registering a Handset to the Base Unit

The supplied handset and base unit are pre-registered. If for some reason the handset is not registered to the baseunit, re-register the handset.

1 Handset:

 $[MENU] \rightarrow #130$

2 Base unit:

Press and hold MLOCATORN forabout 5 seconds until theregistration tone sounds.

- If all registered handsets startringing, press [LOCATOR] againto stop, then repeat this step.
- The next step must be completedwithin 90 seconds.

3 Handset:

Press [OK], then wait until a longbeep sounds.

Note:

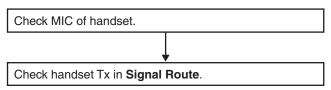
- While registering, "Base in registering" is displayed on allregistered handsets.
- When you purchase an additionalhandset, refer to the additionalhandset's installation manual forregistration.

10.1.8. Deregistering a Handset

A handset can cancel its ownregistration to the base unit, or otherhandsets registered to the same baseunit. This allows the handset to end itswireless connection with the system.

- 1 [MENU] \rightarrow #131
 - All handsets registered to thebase unit are displayed.
- 2 (♦): Select the handset you want tocancel. → [SELECT]
- 3 (\updownarrow): "Yes" \rightarrow [SELECT]
- 4 [OFF]

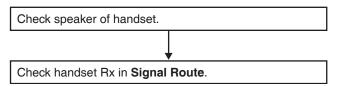
10.1.9. Check Handset Transmission



Cross Reference:

Signal Route (P.25)

10.1.10. Check Handset Reception



Cross Reference:

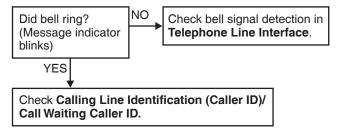
Signal Route (P.25)

Note:

When checking the RF part, Refer to **Check the RF part** (P.41).

10.1.11. Check Caller ID

BASE UNIT



Cross Reference:

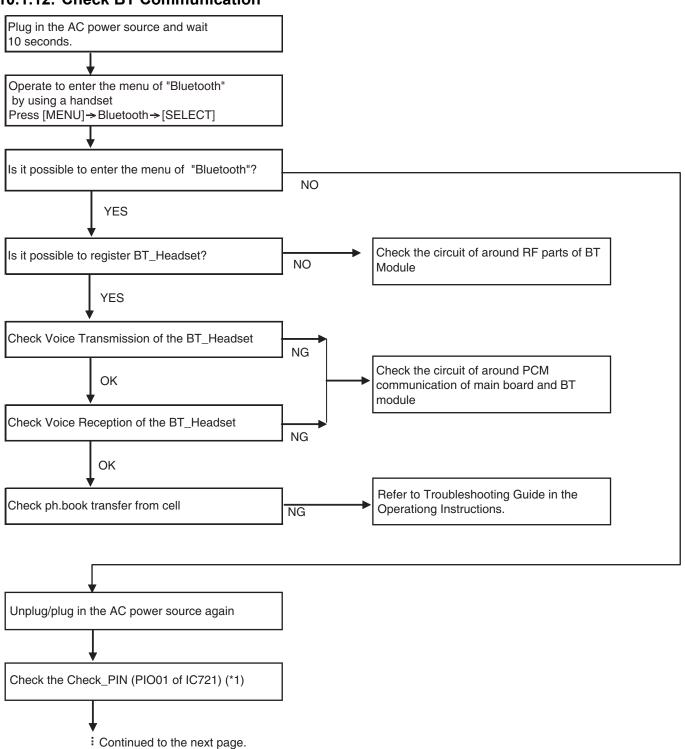
Telephone Line Interface (P.16)

Calling Line Identification (Caller ID)/Call Waiting Caller ID (P.18)

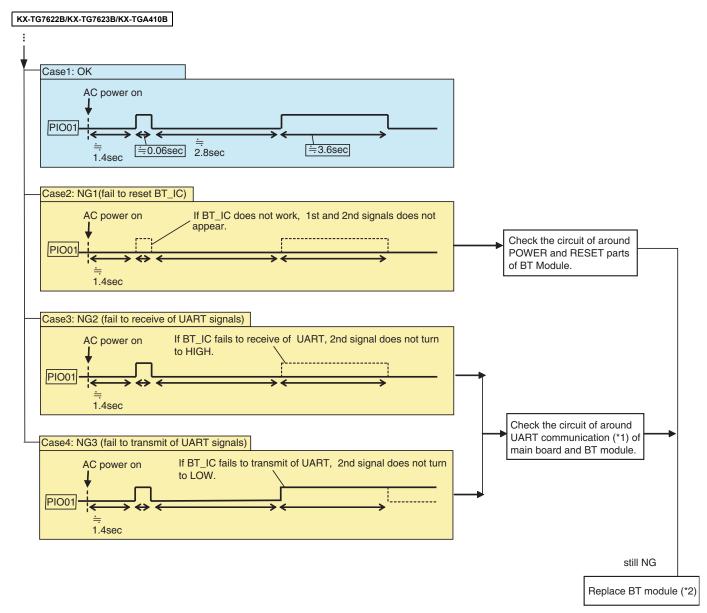
Note:

- Make sure the format of the Caller ID service of the Telephone company that the customer subscribes to.
- It is also recommended to confirm that the customer is really a subscriber of the service.

10.1.12. Check BT Communication



Cross Reference: Bottom View (P.82)



Cross Reference:

Schematic Diagram (Base Unit_RF) (P.76)

Note:

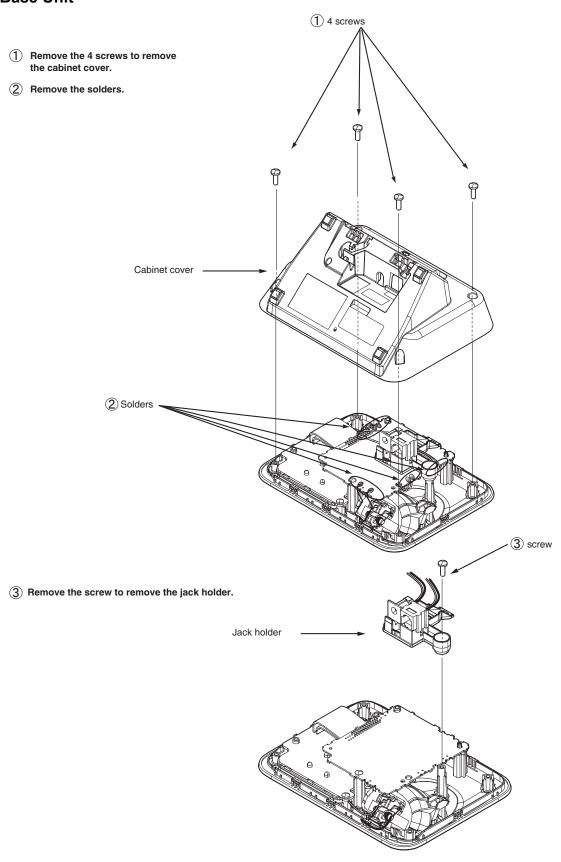
(*2) After replacing, need to adjust the frequency of BT.

Refer to Things to Do after Replacing IC or X'tal (P.63)

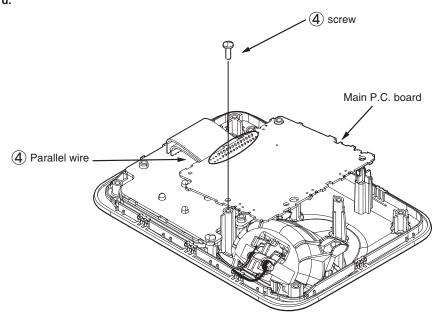
11 Disassembly and Assembly Instructions

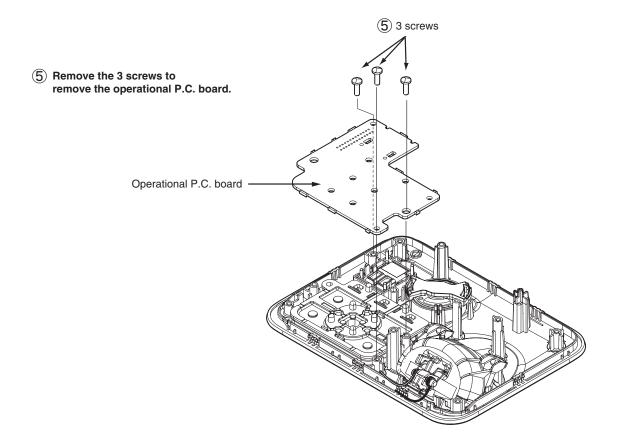
11.1. Disassembly Instructions

11.1.1. Base Unit



(4) Remove the parallel wire and screw to remove the main P.C. board.

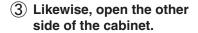


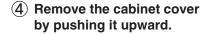


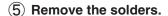
11.1.2. Handset

1 Remove the 2 screws.

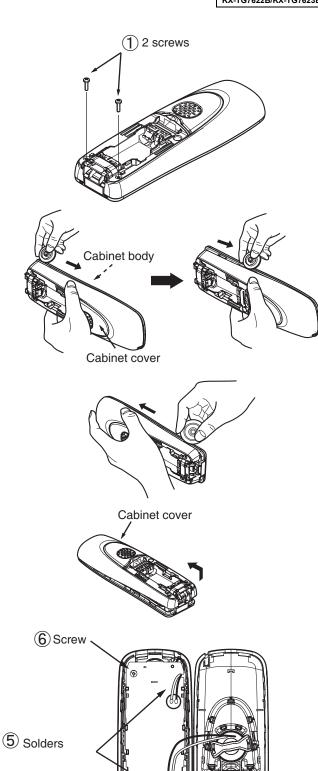
② Insert a JIG (PQDJ10006Y) between the cabinet body and the cabinet cover, then pull it along the gap to open the cabinet.







6 Remove the screw to remove the main P. C. board.

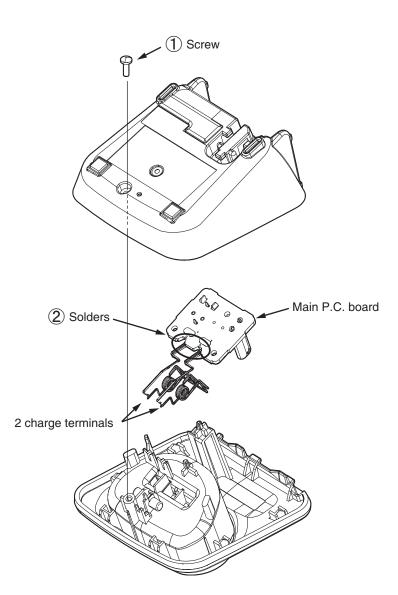


Main P.C. board -

11.1.3. Charger Unit

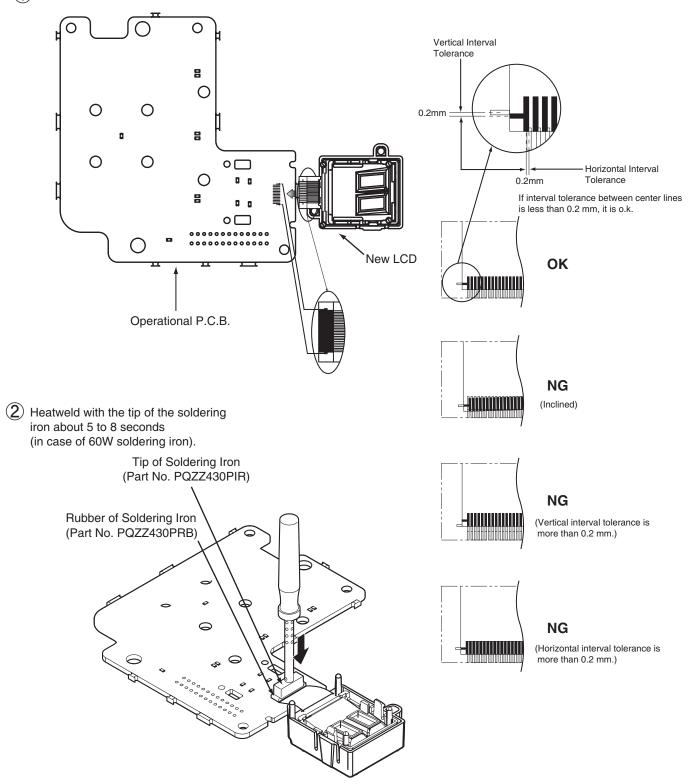
(1) Remove the screw to remove the cabinet cover.

(2) Remove the solders to remove the 2 charge terminals.

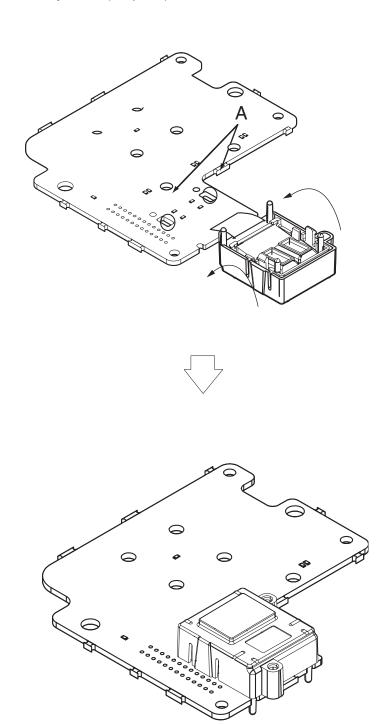


11.2. How to Replace the Base Unit LCD

1 Fit the heatseal of a new LCD.



3 Attach the LCD and fix by hook A (two points).

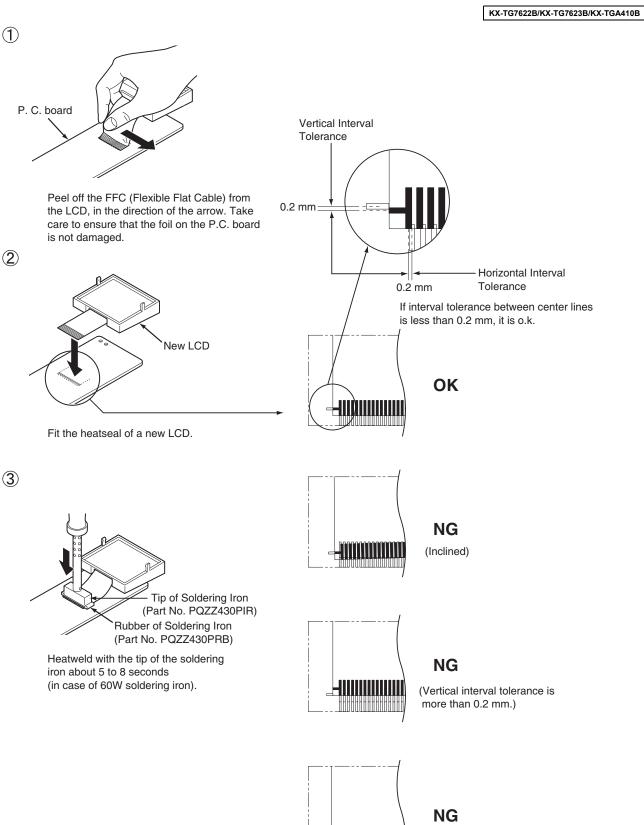


11.3. How to Replace the Handset LCD

Note:

The illustrations are simplified in this page.

They may differ from the actual product.



(Horizontal interval tolerance is

more than 0.2 mm.)

12 Measurements and Adjustments

This chapter explains the measuring equipment, the JIG connection, and the PC setting method necessary for the measurement in **Troubleshooting Guide** (P.33)

12.1. Equipment Required

- Digital multi-meter (DMM): it must be able to measure voltage and current.
- · Oscilloscope.
- Frequency counter: It must be precise enough to measure intervals of 1 Hz (precision; ±4 ppm) Hewlett Packard, 53131A is recommended.
- DECT tester: Rohde & Schwarz, CMD 60 is recommended.
 This equipment may be useful in order to precisely adjust like a mass production.

12.2. The Setting Method of JIG

<Preparation>

Serial JIG cable: PQZZ1CD300E*

• PC which runs in DOS mode

• Batch file CD-ROM for setting: PNZZTG7621M

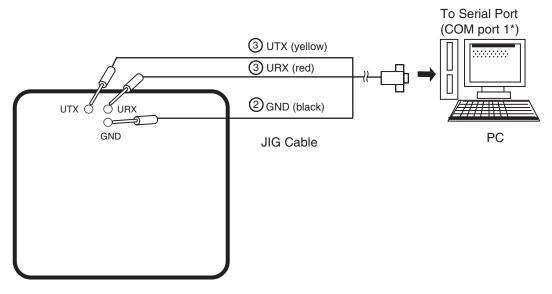
Note:

*: If you have the JIG Cable for TCD500 series (PQZZ1CD505E), change the following values of resistance. Then you can use it as a JIG Cable for both TCD300 and TCD500 series. (It is an upper compatible JIG Cable.)

Resistor	Old value (kΩ)	New value (kΩ)
R2	22	3.3
R3	22	3.3
R4	22	4.7
R7	4.7	10

12.2.1. Connections (Base Unit)

- 1 Connect the AC adaptor.
- (2) Connect the JIG Cable GND (black).
- (3) Connect the JIG Cable RX (red) and TX (yellow).



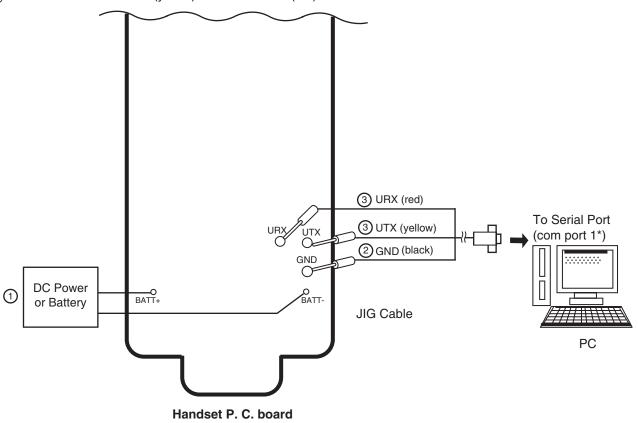
Base unit P. C. board

Note:

*: COM port names may vary depending on what your PC calls it.

12.2.2. Connections (Handset)

- ①Connect the DC Power or Battery to BATT+ and BATT-.
- ② Connect the JIG cable GND (black) to GND.
- ③ Connect the JIG cable UTX (yellow) to UTX and URX (red) to URX.



Note:

*: COM port names may vary depending on what your PC calls it.

12.2.3. How to install Batch file into P.C.

- 1. Insert the Batch file CD-ROM into CD-ROM drive and copy PNZZTG**** folder to your PC (example: D drive).
- 2. Open an MS-DOS mode window.

<Example for Windows>

On your computer, click [Start], select Programs

(All Programs for Windows XP/Windows Server 2003), then click

MS-DOS Prompt. (for Windows 95/Windows 98)

Accessories-MS-DOS Prompt. (for Windows Me)

Command Prompt. (for Windows NT 4.0)

Or

Accessories-Command Prompt.

(for Windows 2000/Windows XP/Windows Server 2003)

- **3.** At the DOS prompt, type "D:" (for example) to select the drive, then press the **Enter** key.
- **4.** Type "CD ¥PNZZTG****", then press the Enter key.
- **5.** Type "SET_COM=X", then press the Enter key
- (X: COM port number used for the serial connection on your PC).
- **6.** Type "READID", then press the Enter key.
 - •If any error messages appear, change the port number or check the cable connection.
 - •If any value appear, go to next step.
- 7. Type "DOSKEY", then press the Enter key.

<Example>

- C: ¥Documents and Settings>D:
- D: ¥>CD ¥PNZZTG****
- D: ¥PNZZTG**** >SET_COM=X
- D: ¥PNZZTG****>READID
- 00 52 4F A8 A8
- D: ¥PNZZTG****>DOSKEY
- D: ¥PNZZTG****>_

<Example: error happens>

- C: ¥Documents and Settings>D:
- D: ¥>CD ¥PNZZTG****
- D: ¥PNZZTG**** >SET_COM=X
- D: ¥PNZZTG****>READID
 CreateFile error

ERROR 10: Can't open serial port

D: ¥PNZZTG ****>_

Note:

• "****" varies depending on the country or models.

12.2.4. Commands

See the table below for frequently used commands.

Command name		Function	Example		
XBT 0		Base unit only.	Type "sendchar XBT 0".		
		For excluding failure of command	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
		response.			
		Please send this command at first			
		before other command is executed.			
		*However, if you want to execute "#X"			
		command			
		then DO NOT USE this command.			
rdeeprom		Read the data of EEPROM	Type "rdeeprom 00 00 FF", and the data from address		
			"00 00" to "FF" is read out.		
readid		Read ID (RFPI)	Type "readid", and the registered ID is read out.		
writeid		Write ID (RFPI)	Type "writeid 00 18 E0 0E 98", and the ID "0018 E0 0E		
			98" is written.		
hookoff		Off-hook mode on Base	Type "hookoff".		
hookon		On-hook mode on Base	Type "hookon".		
getchk (Base unit)		Read checksum	Type "getchk".		
How to use of	1.rdeeprom	Read EEPROM	Type "RdEeprom 03 7D 04", and the data from address		
"getchk"	'		"03 7D" to "03 80" is read out		
in Handset			*This command gets 4 byte "WW", "XX", "YY", "ZZ".		
			*Please NEVER forget these 4 byte data!		
	2.sendchar epw	Write EEPROM	Type "sendchar epw 03 7D 04 FF FF FF FF"		
	3.sendchar RST	Reset baseset	Type "sendchar RST"		
	4.getchk	Read checksum	Type "getchk".		
	5.sendchar epw	Write EEPROM	Type "sendchar epw 03 7D 04 WW XX YY ZZ"		
	o.condonal opii	Willo EE, Itolii	*"WW", "XX", "YY", "ZZ" is 4 byte data that already read		
			from same address.		
wreeprom		Write the data of EEPROM	Type "wreeprom 01 23 45". "01 23" is address and "45"		
Мооргоні		White the data of EEF Heim	is data to be written.		
hs_burst		Handset outputs RF power in burst test Type"hs_burst"			
_		mode	'' =		
bs_burst		Base unit outputs RF power in burst	Type"bs burst"		
_		test mode on antenna 2	'' =		
tx_high		Keep TX power high	Type"tx_high"		
tx_low		Keep TX power low	Type"tx_low"		
·		1 - 2 - 2	7,112		
		How to using "#X" com	mand for base unit		
XBT		Enter this command before using	Type "sendchar XBT 1" and then "OK" is back when it		
		following command "#X", "bs_burst",	succeeds.		
		tx_high" "tx_low" for Base Unit.	(caution)		
		acg acoo. 2000 0	Before entering this command, wait 10 seconds after		
			power on the base unit		
#X		Read and Write BT parameters	[Read MAC address]		
			Type"sendchar #X sme" and MAC address is read out		
(Attention)			(exp. sendchar #XXsme 0080 F08C FFD1)		
,	#X" command, must be		[Write MAC address]		
the "X" must be capita	l ·		Type"sendchar #X sme **** **** and		
letter.			(note) part of **** should be set correct MAC address		
			[Read the data of crystal of BT]		
			Type"sendchar #X nc" and adjustment parameter of		
			crystal		
			of BT is read out		
			(exp. #XXnc=0x1D)		
			[Write the data of crystal of BT]		
			Type"sendchar #X nc **" and adjustment parameter of		
			crystal		
			of BT is read out		
			(note) part of ** should be set the adjusted value.		

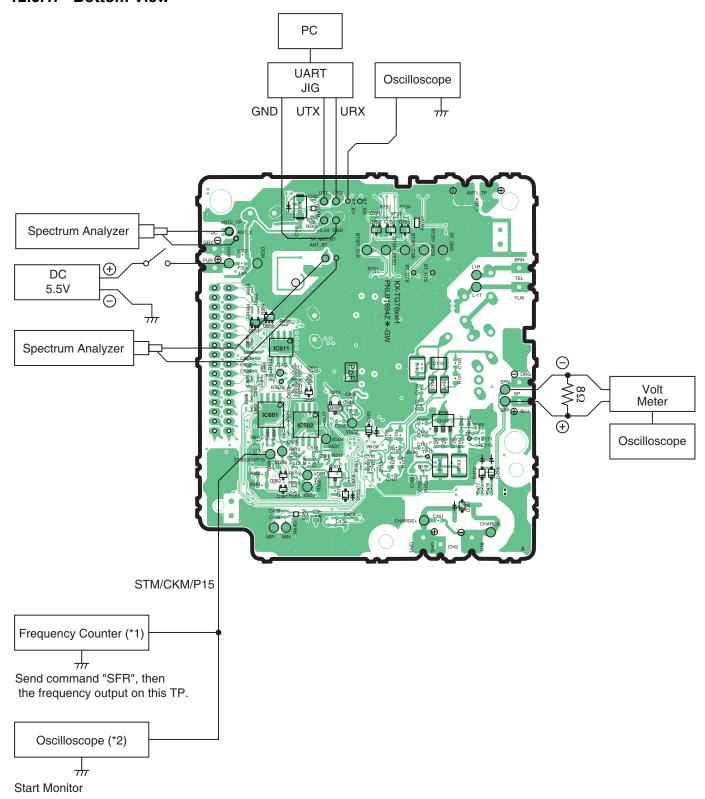
Note:

For the command related with BT XBT and #X, the example of this, refer to Things to Do after Replacing IC or X'tal (P.63)

12.3. Adjustment Standard (Base Unit)

When connecting the simulator equipment for checking, please refer to below.

12.3.1. Bottom View



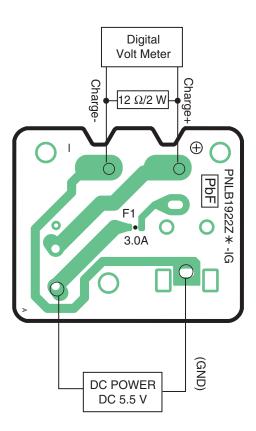
Note:

- (*1) is referred to No.2 of Check Check Table for RF part (P.43)
- (*2) is referred to Power Supply Circuit/Reset Circuit (P.14)

12.4. Adjustment Standard (Charger Unit)

When connecting the simulator equipment for checking, please refer to below.

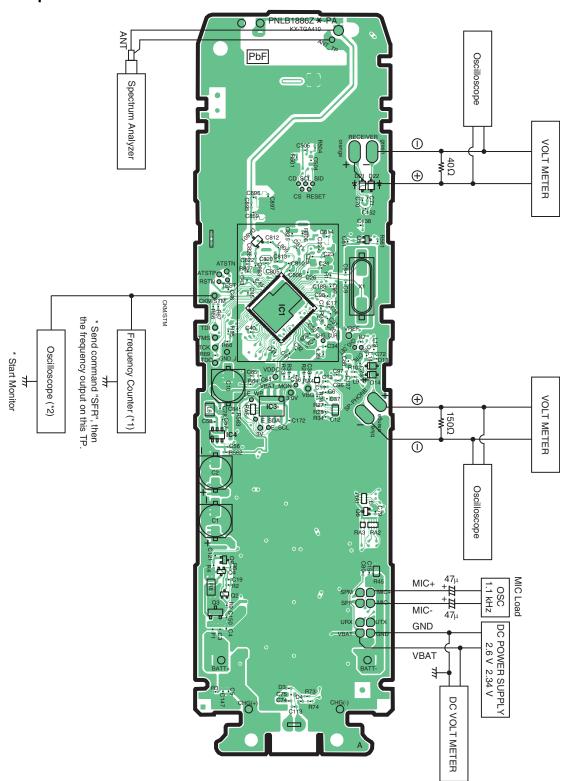
12.4.1. Bottom View



12.5. Adjustment Standard (Handset)

When connecting the simulator equipment for checking, please refer to below.

12.5.1. Component View



Note:

- (*1) is referred to No.2 of Check Check Table for RF part (P.43)
- (*2) is referred to Power Supply Circuit/Reset Circuit (P.22)

12.6. Things to Do after Replacing IC or X'tal

If repairing or replacing EEPROM and X'tal, it is necessary to download the required data such as Programming data or adjustment data, etc. in memory.

The set doesn't operate if it is not executed.

12.6.1. How to download the data

12.6.1.1. Base Unit

First, operate the PC setting according to The Setting Method of JIG (P.56).

Then download the appropriate data according to the following procedures.

Items		How to download/Required adjustment		
BBIC(IC501)	Programming data is stored in memory.	1) Clock adjustment: Refer to Check Point (H).(*2)		
EEPROM (IC611)	Adjusted parameter data is stored in memory. (country version batch file, default batch file, etc.)	1) Change the address "0001" of EEPROM to "AA" to download the data. 2) Default batch file: Execute the command "default.bat". 3) Country version batch file: Execute the command "TG7621US_US_RevXXX_YYY.bat". (*1) 4) Clock adjustment		
FLASH1 (IC601)	Voice prompt data is stored in memory. (vary depending on country version)	1) Wait more than 15 seconds after connecting the JIG Cable. 2) Execute the command "VPDL2011 -AA ZZZ.bin" (*1). (writing time: approx. 1 min (115200 bps).)		
FLASH2 (IC502)	Program D/L	1) Make sure to connect the JIG cable and disconnect the DC Power in order to download the data. 2) Execute the command "flw441 *******.hex". 3) Connect the DC Power. 4) Press the PC Enter key once. 5) After a few minutes, "Successful upgrade" is displayed on the PC indicating downloading has finished. 6) Detach the JIG cable, then disconnect the DC Power. 7) Connect the DC Power. 8) Connect the JIG cable again, and execute the command "getchk", then confirm the checksum value is correct. If the downloading fails, start again from step 1). 9) Default batch file: Execute the command "default.bat". 10) Country version batch file: Execute the command "TG7621US_US_RevXXX_YYY.bat". (*1) 11) Clock adjustment: Refer to Check Point (H). (*2)		
X'tal (X1)	System clock	Clock adjustment data is in EEPROM, adjust the data again after replacing it. 1) Apply 5.5V between DCP ad DCM with DC power. 2) Input Command "sendchar sfr", then you can confirm the current value. 3) Check X'tal Frequency.(10.368MHz ± 41Hz). 4) If the frequency is not 10.368MHz ±41Hz, adjust the frequency of CLK executing the command "sendchar sfr xx xx (where xx is the value)" so that the reading of the frequency counter is 10.368MHz ±5Hz.		

Note:

(*1) XXX_YYY: revision number, ZZZ:Voice prompt, AA: Baud rate(9600/19200/57600/115200)

"XXX_YYY and "ZZZ" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG** (P.56).

When adjust the frequency the BT Unit or write the MAC address to the BT Unit.

	Item	Test command		Description	
		Input	Echo back		
1	Power on	-	-	Wait 10seconds and connect JIG	
2	Test mode	sendchar XBT 1 🕹 sendchar #X ts 🕹	OK #XXTEST	Enter"XBT 1" and then "OK" is back when it succeeds to enter test mode.	
3	Confirm a default value	Seriuciiai #X iic 2	#XXnc=0x1A	Confirm a default value before adjusting the frequency.	
4	Adjust the frequency	sendchar #X b3 39 19 년 sendchar nc,	#XXTS ch=2441 pwr=19 #XXnc=0x,	Adjust the frequency to "2441MHz ± 10kHz" by changing the value of, Test Piont: ANT-C3, refer to Bottom View (P.82)	

Note:

☑: Enter key

KX-TG7622B/KX-TG7623B/KX-TGA410B

12.6.1.2. Handset

First, operate the PC setting according to The Setting Method of JIG (P.56).

Then download the appropriate data according to the following procedures.

	Items	How to download/Required adjustment		
EEPROM (IC3)	Adjusted parameter data is stored in memory. (country version batch file, default batch file, etc.)	1) Default batch file: Execute the command "default.bat". 2) Default batch file (remaining): Execute the command "TGA410US_DEF_RevXXX_YYY.bat". (*2) 3) Country version batch file: Execute the command "TGA410US_US_RevXXX_YYY.bat". (*2) 4) Clock adjustment 5) 2.35 V setting and battery low detection		
X'tal (X1)	System clock	1) Apply 2.6V between BATT+ and BATT- with DC power. 2) Input Command "sendchar sfr", then you can confirm the current value. 3) Check X'tal Frequency.(13.824 MHz ± 100 Hz). 4) If the frequency is not 13.824 MHz ± 100 Hz, adjust the frequency of CLK executing the command "sendchar sfr xx xx (where xx is the value)" so that the reading of the frequency counter is 13.824000 MHz ± 5 Hz.		

Note:

(*2) XXX_YYY: revision number

"XXX_YYY" vary depending on the country version. You can find them in the batch file, PNZZ- mentioned in **The Setting Method of JIG** (P.56).

12.7. Frequency Table

	Ch. (hex)	TX/RX Frequency (MHz)	
Channel 0	00	1928.448	
Channel 1	01	1926.720	
Channel 2	02	1924.992	
Channel 3	03	1923.264	
Channel 4	04	1921.536	

KX-TG7622B/KX-TG7623B/KX-TGA410B 12.8. Bluetooth Frequency Table

Ch.	Frequency (MHz)	Ch.	Frequency (MHz)	Ch.	Frequency (MHz)
0	2402	33	2435	66	2468
1	2403	34	2436	67	2469
2	2404	35	2437	68	2470
3	2405	36	2438	69	2471
4	2406	37	2439	70	2472
5	2407	38	2440	71	2473
6	2408	39	2441	72	2474
7	2409	40	2442	73	2475
8	2410	41	2443	74	2476
9	2411	42	2444	75	2477
10	2412	43	2445	76	2478
11	2413	44	2446	77	2479
12	2414	45	2447	78	2480
13	2415	46	2448	,	
14	2416	47	2449		
15	2417	48	2450		
16	2418	49	2451		
17	2419	50	2452		
18	2420	51	2453		
19	2421	52	2454		
20	2422	53	2455		
21	2423	54	2456		
22	2424	55	2457		
23	2425	56	2458		
24	2426	57	2459		
25	2427	58	2460		
26	2428	59	2461		
27	2429	60	2462	\neg	
28	2430	61	2463		
29	2431	62	2464		
30	2432	63	2465	\neg	
31	2433	64	2466	\neg	
32	2434	65	2467	_	

13 Miscellaneous

13.1. How to Replace the LLP (Leadless Leadframe Package) IC

Note:

This description is only applied on the model with Shield case.

13.1.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of 700 °F ± 20 °F (370 °C ± 10 °C)

Note:

We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

· Hot Air Desoldering Tool

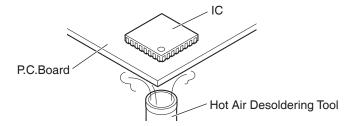
Temperature: 608 °F ± 68 °F (320 °C ± 20 °C)

13.1.2. Caution

- To replace the IC efficiently, choose the right sized nozzle of the hot air desoldering tool that matches the IC package.
- Be careful about the temperature of the hot air desoldering tool not to damage the PCB and/or IC.

13.1.3. How to Remove the IC

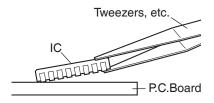
1. Heat the IC with a hot air desoldering tool through the P.C.Board.



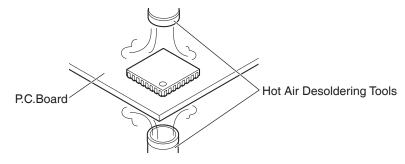
2. Pick up the IC with tweezers, etc. when the solder is melted completely.

Note:

• Be careful not to touch the peripheral parts with tweezers, etc. They are unstable.



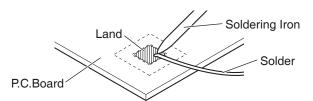
When it is hard to melt the solder completely, heat it with a hot air desoldering tool through the IC besides through the P.C.Board.



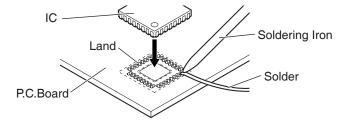
3. After removing the IC, clean the P.C.Board of residual solder.

13.1.4. How to Install the IC

1. Place the solder a little on the land where the radiation GND pad on IC bottom is to be attached.

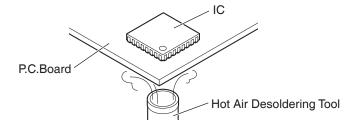


- 2. Place the solder a little on the land where IC pins are to be attached, then place the IC. **Note:**
 - When placing the IC, the positioning should be done very carefully.



- 3. Heat the IC with a hot air desoldering tool through the P.C.Board until the solder on IC bottom is melted.

 Note:
 - Be sure to place it precisely, controlling the air volume of the hot air desoldering tool.



4. After soldering, confirm there are no short and open circuits with visual inspection.

13.2. How to Replace the Flat Package IC

Even if you do not have the special tools (for example, a spot heater) to remove the Flat IC, with some solder (large amount), a soldering iron and a cutter knife, you can easily remove the ICs that have more than 100 pins.

13.2.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of 700 °F \pm 20 °F (370 °C \pm 10 °C)

Note: We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

Flux

Recommended Flux: Specific Gravity \rightarrow 0.82. Type \rightarrow RMA (lower residue, non-cleaning type)

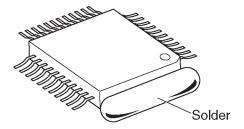
Note: See About Lead Free Solder (PbF: Pb free) (P.4)

13.2.2. How to Remove the IC

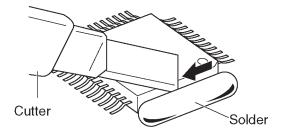
1. Put plenty of solder on the IC pins so that the pins can be completely covered.

Note:

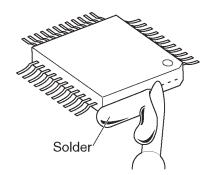
If the IC pins are not soldered enough, you may give pressure to the P.C. board when cutting the pins with a cutter.



2. Make a few cuts into the joint (between the IC and its pins) first and then cut off the pins thoroughly.



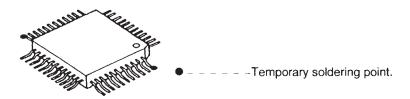
3. While the solder melts, remove it together with the IC pins.



When you attach a new IC to the board, remove all solder left on the board with some tools like a soldering wire. If some solder is left at the joint on the board, the new IC will not be attached properly.

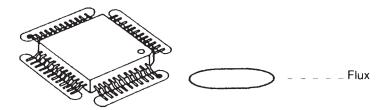
13.2.3. How to Install the IC

1. Temporarily fix the FLAT PACKAGE IC, soldering the two marked pins.

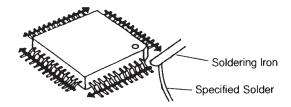


*Check the accuracy of the IC setting with the corresponding soldering foil.

2. Apply flux to all pins of the FLAT PACKAGE IC.

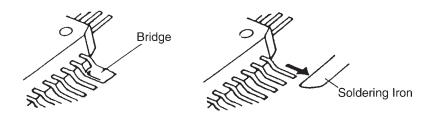


3. Solder the pins, sliding the soldering iron in the direction of the arrow.



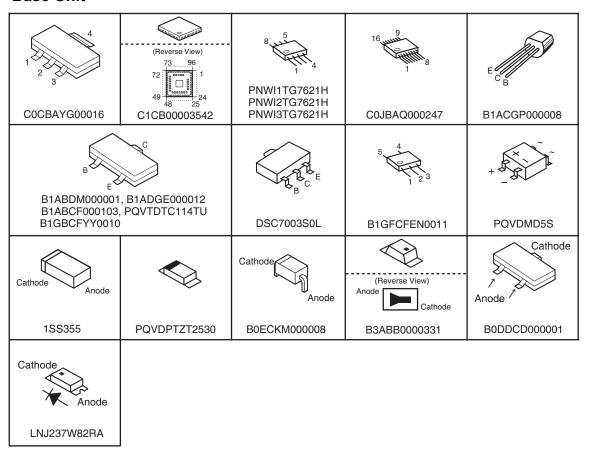
13.2.4. How to Remove a Solder Bridge

- 1. Lightly resolder the bridged portion.
- 2. Remove the remaining solder along the pins using a soldering iron as shown in the figure below.

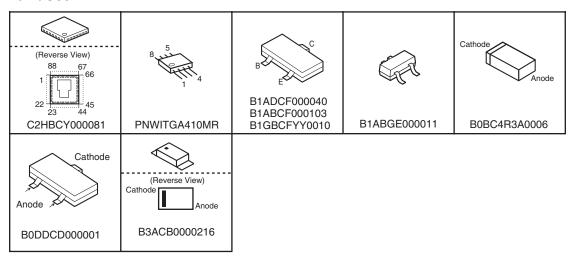


13.3. Terminal Guide of the ICs, Transistors and Diodes

13.3.1. Base Unit



13.3.2. Handset



14 Schematic Diagram

14.1. For Schematic Diagram

14.1.1. Base Unit (Schematic Diagram (Base Unit_Main))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

Components identified by \triangle mark have special characteristics important for safety. When replacing any of these components, use only the manufacture's specified parts.

2. The schematic diagrams may be modified at any time with the development of new technology.

14.1.2. Handset (Schematic Diagram (Handset Main))

Notes:

- 1. DC voltage measurements are taken with an oscilloscope or a tester with a ground.
- 2. The schematic diagrams may be modified at any time with the development of new technology.

14.1.3. Charger Unit (Schematic Diagram (Charger Unit))

Notes

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

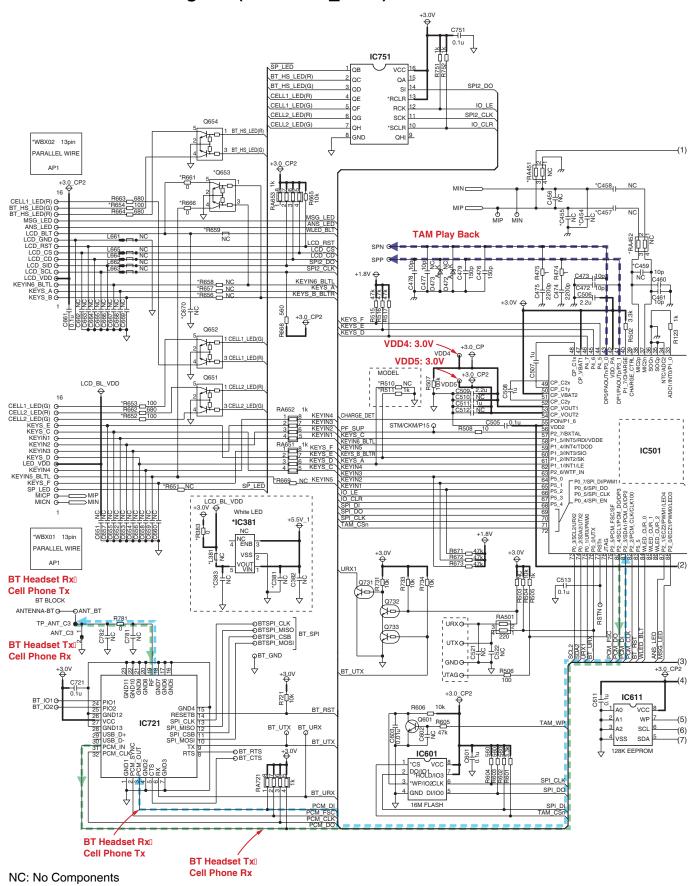
Components identified by \triangle mark have special characteristics important for safety. When replacing any of these components, use only the manufacture's specified parts.

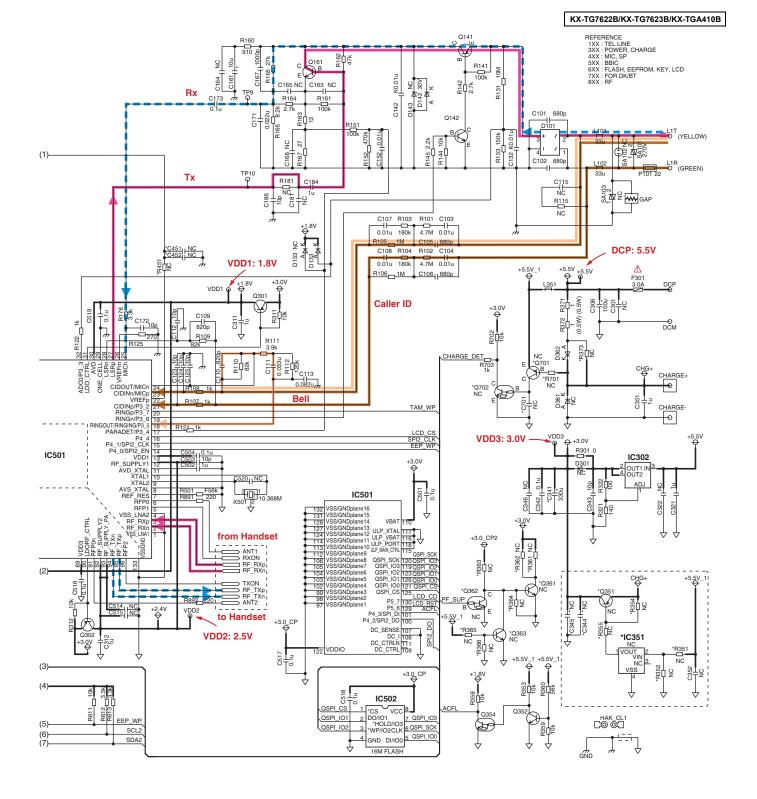
2. The schematic diagrams may be modified at any time with the development of new technology.

KX-TG7622B/KX-TG7623B/KX-TGA410B

Memo

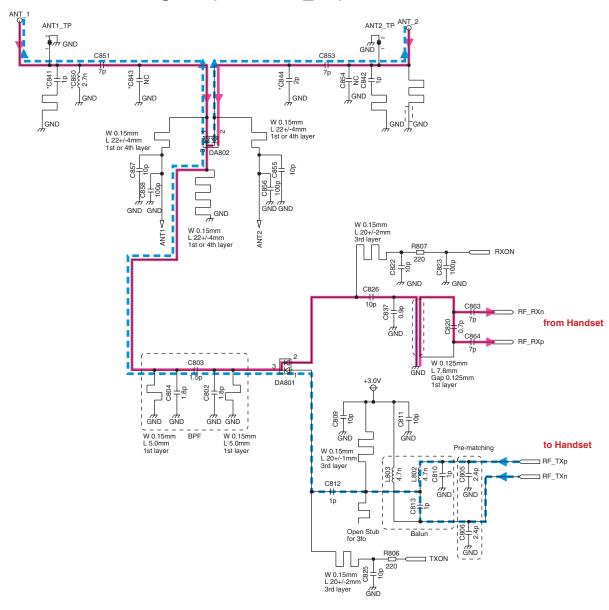
14.2. Schematic Diagram (Base Unit_Main)





NC: No Components KX-TG7622/7623 SCHEMATIC DIAGRAM (Base Unit_Main)

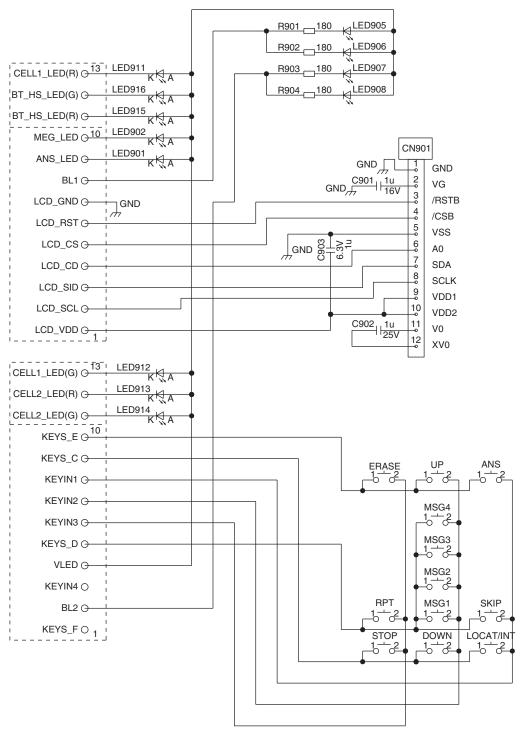
14.3. Schematic Diagram (Base Unit_RF)





NC: No Components KX-TG7622/7623 SCHEMATIC DIAGRAM (Base Unit_RF)

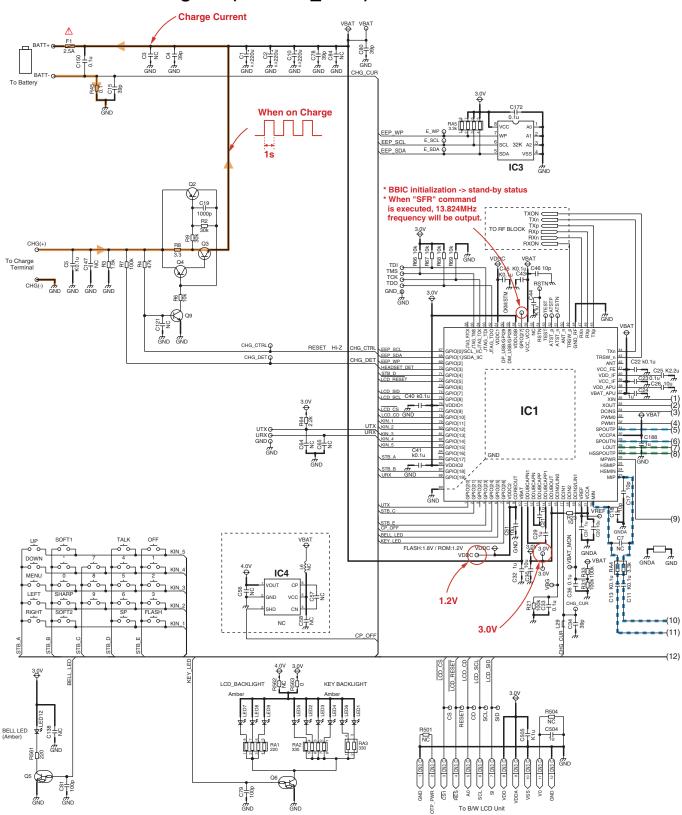
14.4. Schematic Diagram (Base Unit_Operation)



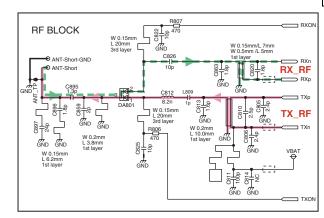
CT2 CT1 CARBON_TEST

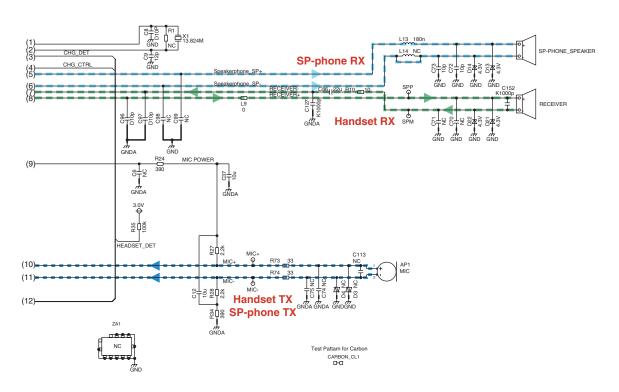
NC: No Components KX-TG7622/7623 SCHEMATIC DIAGRAM (Base Unit_Operation)

14.5. Schematic Diagram (Handset_Main)



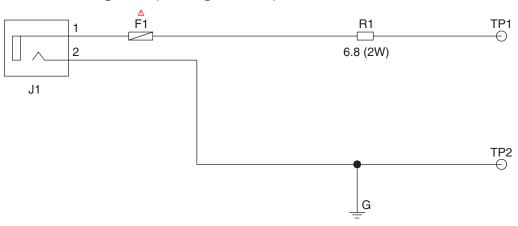
NC: No Components





NC: No Components KX-TGA410 SCHEMATIC DIAGRAM (Handset_Main)

14.6. Schematic Diagram (Charger Unit)

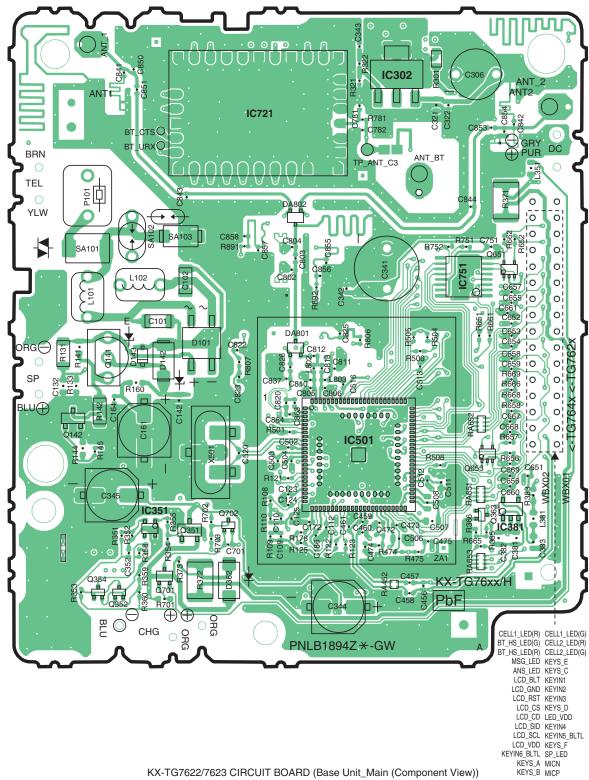


SCHEMATIC DIAGRAM (Charger Unit)

15 Printed Circuit Board

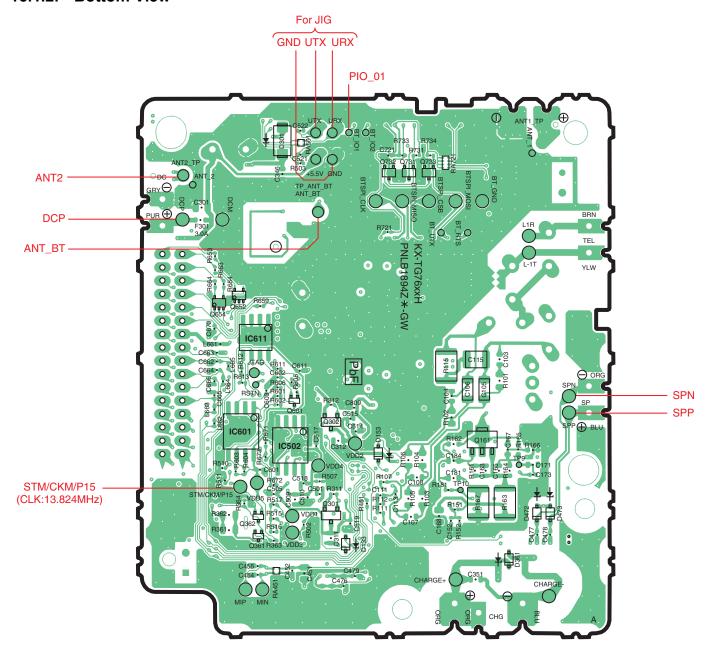
15.1. Circuit Board (Base Unit_Main)

15.1.1. Component View



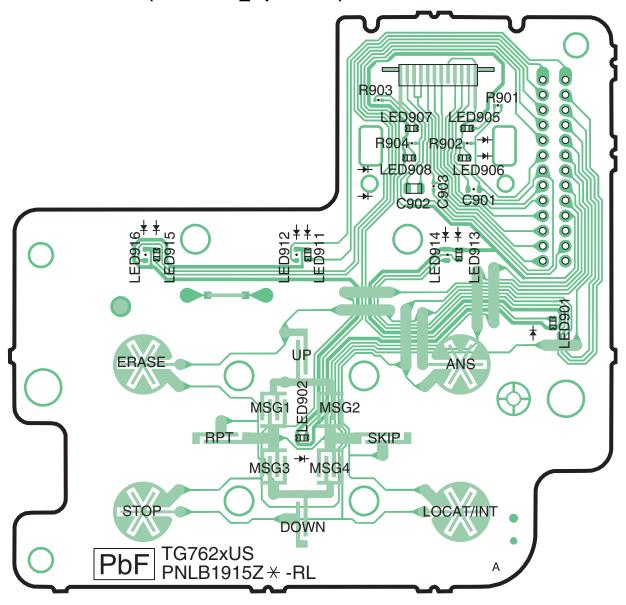
KX-TG7622/7623 CIRCUIT BOARD (Base Unit_Main (Component View))

15.1.2. Bottom View



KX-TG7622/7623 CIRCUIT BOARD (Base Unit_Main (Bottom View))

15.2. Circuit Board (Base Unit_Operation)



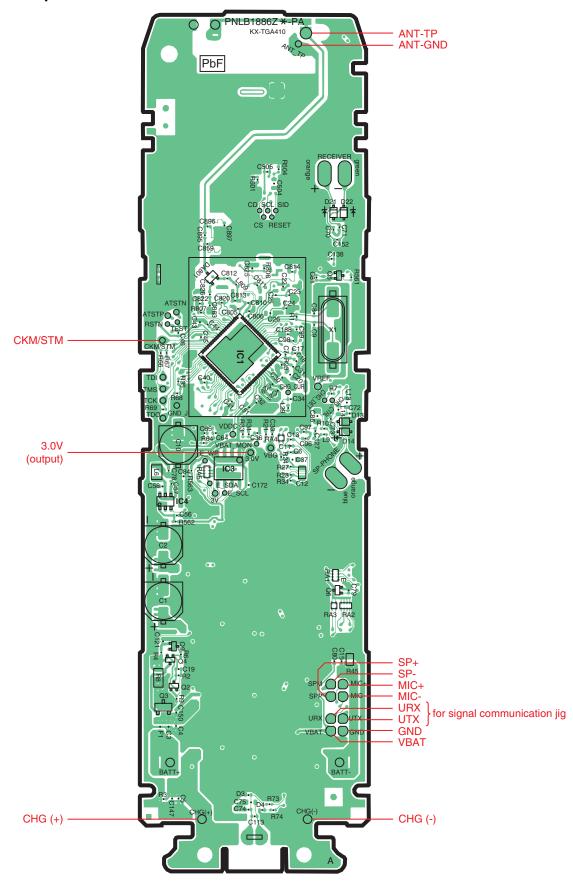
KX-TG7622/7623 CIRCUIT BOARD (Base Unit_Operation (Component View))

KX-TG7622B/KX-TG7623B/KX-TGA410B

Memo

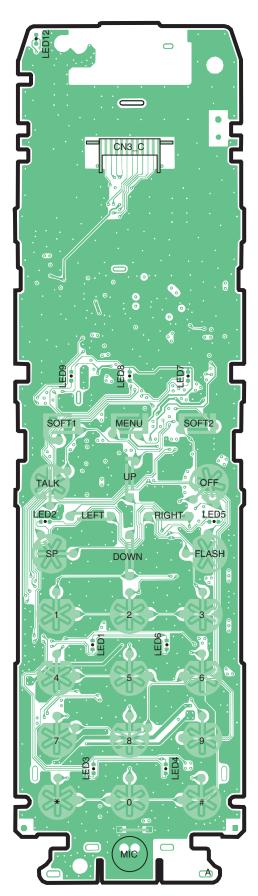
15.3. Circuit Board (Handset_Main)

15.3.1. Component View



KX-TGA410 CIRCUIT BOARD (Handset_Main (Component View))

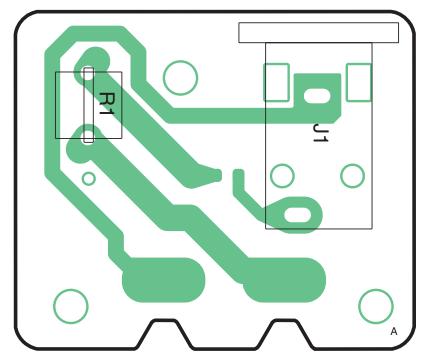
15.3.2. Bottom View



KX-TGA410 CIRCUIT BOARD (Handset_Main (Bottom View))

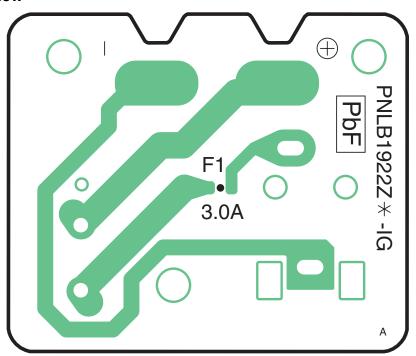
15.4. Circuit Board (Charger Unit)

15.4.1. Component View



CIRCUIT BOARD (Charger Unit (Component View))

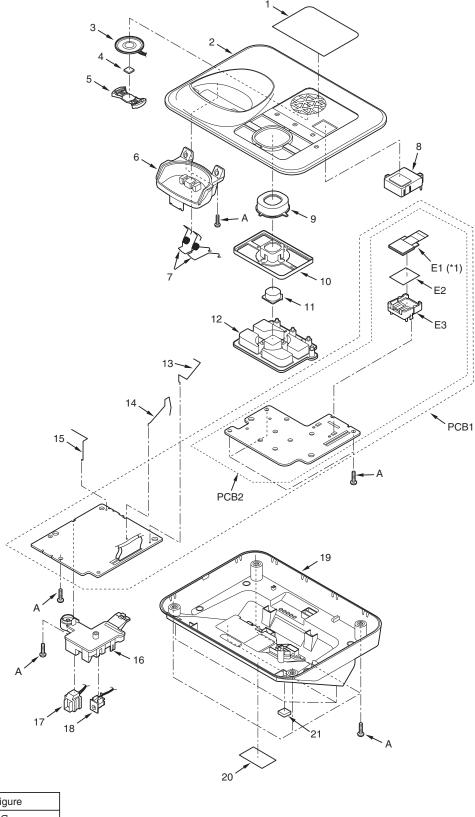
15.4.2. Bottom View



CIRCUIT BOARD (Charger Unit (Bottom View))

16 Exploded View and Replacement Parts List

16.1. Cabinet and Electrical Parts (Base Unit)

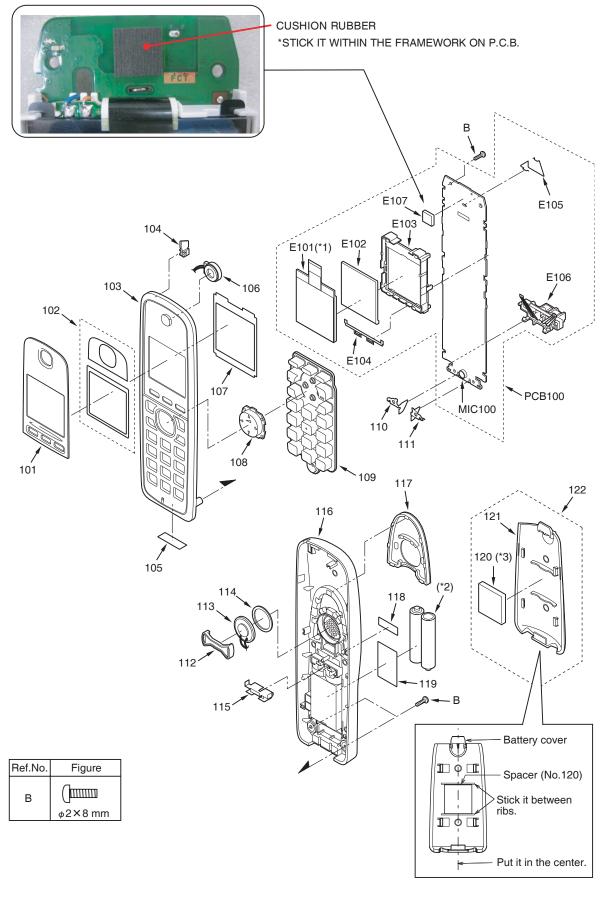


Ref.No.	Figure
А	φ2.6 x 8mm

Note:

(*1) This cable is fixed by welding. Refer to **How to Replace the Base Unit LCD** (P.53)

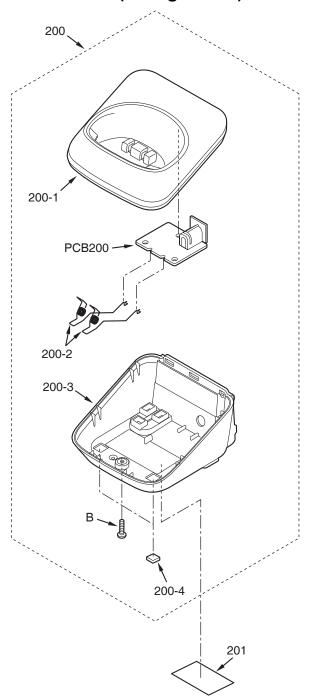
16.2. Cabinet and Electrical Parts (Handset)



Note:

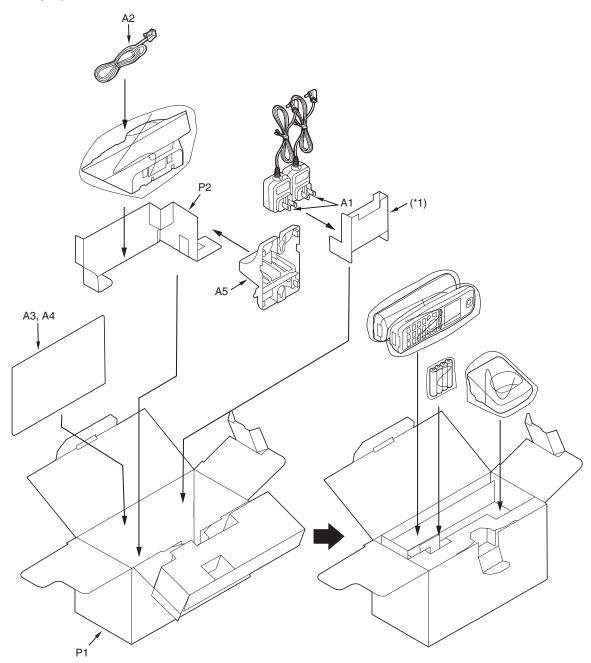
- (*1) This cable is fixed by welding. Refer to How to Replace the Handset LCD (P.54).
- (*2) The rechargeable Ni-MH battery HHR-4DPA is available through sales route of Panasonic.
- (*3) Attach the SPACER (No. 120) to the exact location described above.

16.3. Cabinet and Electrical Parts (Charger Unit)



16.4. Accessories and Packing Materials

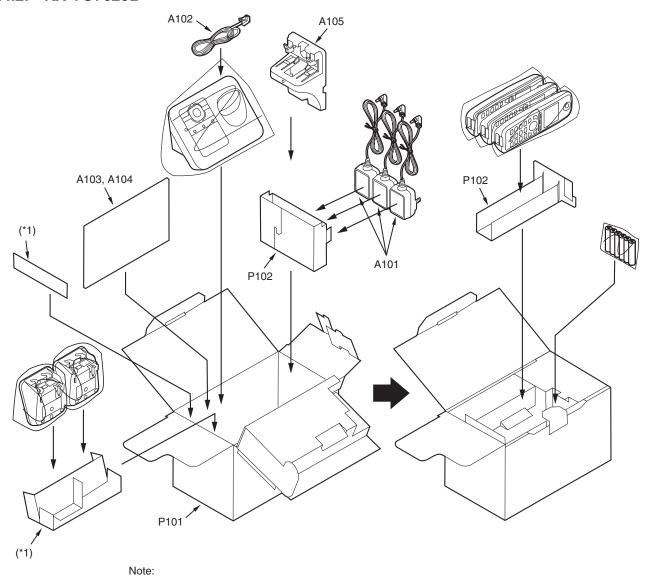
16.4.1. KX-TG7622B



Note

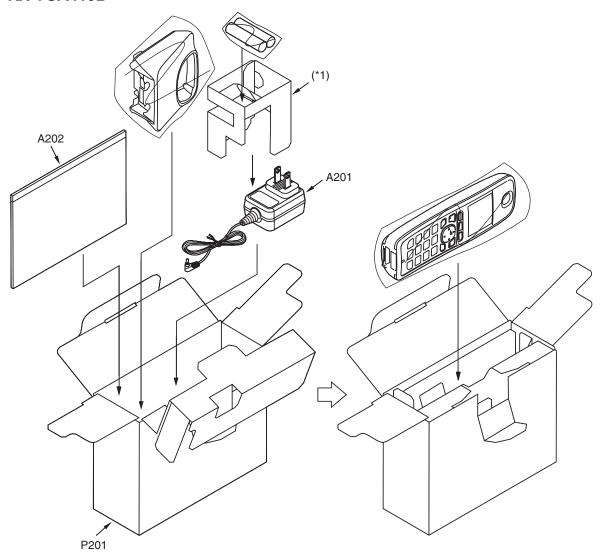
(*1) This pad is a piece of Ref No.P1 (GIFT BOX).

16.4.2. KX-TG7623B



(*1) These pads are pieces of Ref No.P101 (GIFT BOX).

16.4.3. KX-TGA410B



Note:

(*1) This pad is a piece of Ref No.P201 (GIFT BOX).

16.5. Replacement Parts List

1. RTL (Retention Time Limited)

Note:

The "RTL" marking indicates that its Retention Time is Limited.

When production is discontinued, this item will continue to be available only for a specific period of time.

This period of time depends on the type of item, and the local laws governing parts and product retention. At the end of this period, the item will no longer be available.

2. Important safety notice

Components identified by the \triangle mark indicates special characteristics important for safety. When replacing any of these components, only use specified manufacture's parts.

- The S mark means the part is one of some identical parts.For that reason, it may be different from the installed part.
- ISO code (Example: ABS-94HB) of the remarks column shows quality of the material and a flame resisting grade about plastics.
- 5. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) k=1000 Ω , M=1000k Ω All capacitors are in MICRO FARADS (μ F) p= $\mu\mu$ F

*Type & Wattage of Resistor

Туре

Wattage

amago						
10,16:1/8W	14,25:1/4W	12:1/2W	1:1W	2:2W	3:3W	ı

^{*}Type & Voltage Of Capacitor

Type

ECFD:Semi-Conductor	ECCD,ECKD,ECBT,F1K,ECUV:Ceramic
	ECQE,ECQV,ECQG:Polyester
ECUV,PQCUV, ECUE:Chip	ECEA,ECST,EEE:Electlytic
	ECQP:Polypropylene

Voltage

ECQ Type	ECQG ECQV Type	ECSZ Type		Oth	ers	
1H:50V		0F:3.15V	0J	:6.3V	1V	:35V
2A:100V		1A:10V	1A	:10V	50,1H	H:50V
2E:250V		1V:35V	1C	:16V	1J	:16V
2H:500V		0J:6.3V	1E,2	5:25V	2A	:100V

16.5.1. Base Unit

16.5.1.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	NO.			
	1	PNGS1004Z	NET, MESH SHEET	PC-VO
	2	PNKM1200Z1	CABINET BODY	PS-HB
	3	L0AA02A00087	SPEAKER	
	4	PQHG10729Z	RUBBER PARTS, SPEAKER	
	5	PQHR11313Z	GUIDE, SPEAKER	ABS-HB
	6	PNKE1090Z1	CASE, CHARGE TERMINAL	PS-HB
	7	PNJT1064Z	CHARGE TERMINAL	
	8	PNGP1135Z1	PANEL, LCD	PMMA-HB
	9	PNBC1353Z1	BUTTON, NAVIGATOR KEY	ABS-HB
	10	PNHR1385Z	GUIDE, BUTTON	PS-HB
	11	PNBC1345Z1	BUTTON, MESSAGE	PS-HB
	12	PNJK1115Z	KEYBOARD SWITCH	

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	13	PNLA1047Z	ANTENNA, SUB	
	14	PNLA1052Z	ANTENNA, BT	
	15	PNLA1051Z	ANTENNA, SUB	
	16	PNHR1409Z	GUIDE, JACK	PS-HB
	17	PQJJ1T039L	JACK, MODULAR	
	18	K2ECYZ000001	JACK, DC	
	19	PNKF1146Z1	CABINET COVER	PS-HB
	20	PNGT5517Z	NAME PLATE	
	21	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	

16.5.1.2. Main P.C. Board Parts

Note

- (*1) When replacing IC611 or X501, make the adjustment using PNZZTG7621M. Refer to **How to download the data** (P.63) of Things to Do after Replacing IC or X'tal.
- (*2) When replacing the base unit LCD, See **How to** Replace the Base Unit LCD (P.53).

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB1	PNWP1TG7621H	MAIN P.C.BOARD ASS'Y	
			(RTL)	
			(ICs)	
	IC302	C0CBAYG00016	IC	
	IC501	C1CB00003542	IC	
	IC502	PNWI2TG7621H	IC(FLASH)	
	IC601	PNWI3TG7621H		
	IC611	PNWI1TG7621H	IC(EEPROM)(*1)	
	IC751	C0JBAQ000247		
		-	(TRANSISTORS)	
	Q141	B1ACGP000008	TRANSISTOR(SI)	
	Q142		TRANSISTOR(SI)	
	Q161	DSC7003S0L	TRANSISTOR(SI)	
	Q301		TRANSISTOR(SI)	
	Q302		TRANSISTOR(SI)	
	Q352		TRANSISTOR(SI)	s
	Q354		TRANSISTOR(SI)	5
	Q601		TRANSISTOR (SI)	s
				5
	Q651 Q652		TRANSISTOR (SI)	
	-		TRANSISTOR (SI)	
	Q653		TRANSISTOR (SI)	
	Q654		TRANSISTOR(SI)	_
	Q731		TRANSISTOR (SI)	S
	Q732		TRANSISTOR(SI)	S
	Q733	PQVTDTC114TU	TRANSISTOR (SI)	S
			(DIODES)	
	D101	PQVDMD5S	DIODE(SI)	
	D133	1SS355	DIODE(SI)	S
	D142	PQVDPTZT2530		s
	D362	B0ECKM000008	DIODE(SI)	
	DA801	B0DDCD00001	DIODE (SI)	
	DA802	B0DDCD00001	DIODE(SI)	
			(COILS)	
	L101	PQLQXF330K	COIL	S
	L102	PQLQXF330K	COIL	S
	L351	PQLQR2KA113	COIL	S
	L802	G1C4N7Z00006	COIL	
	L803	G1C4N7Z00006	COIL	
			(RESISTOR ARRAYS)	
	RA501	D1H422120001	RESISTOR ARRAY	
	RA651	D1H810240004	RESISTOR ARRAY	s
	RA652	D1H810240004	RESISTOR ARRAY	s
	RA653	D1H810240004	RESISTOR ARRAY	s
	RA721	D1H810240004	RESISTOR ARRAY	s
			(RF)	
	IC721	PNWP3TG7621H	RF UNIT	
		1	(VARISTOR)	
	SA101	J0LF00000048		
			ABSORBER)	
			(RESISTORS)	
	R101	PQ4R10XJ475	4.7M	S

Safety	Ref. No.	Part No.	Part Name & Description	Remark
	R102	PQ4R10XJ475	4.7M	S
	R103	PQ4R10XJ184	180k	S
	R104	PQ4R10XJ184	180k	S
	R105	PQ4R10XJ105	1M	s
	R106 R107	PQ4R10XJ105 ERJ2GEJ102	1M 1k	s
	R107	ERJ2GEJ102	1k	s
	R109	ERJ2GEJ823	82k	s
	R110	ERJ2GEJ823	82k	s
	R111	ERJ2GEJ392	3.9k	S
	R112	ERJ2GEJ124	120k	s
	R121	ERJ2GEJ102	1k	s
	R122	ERJ2GEJ102	1k	S
	R123	ERJ2GEJ102	1k	S
	R125	ERJ2GEJ271	270	s
	R131	PQ4R18XJ106	10M	S
	R133	ERJ3GEYJ154	150k	s
	R141	ERJ3GEYJ104	100k	S
	R142	PQ4R18XJ272	2.7k	S
	R144	ERJ3GEYJ103	10k	S
	R145 R151	ERJ2GEJ222 ERJ2GEJ104	2.2k 100k	s
	R151	ERJ2GEJ104 ERJ2GEJ474X	470k	S
	R160	ERJ3GEYJ911	910	S
	R161	ERJ3GEYJ104	100k	s
	R162	ERJ3GEYJ473	47k	S
	R163	ERJ12YJ120	12	
	R164	ERJ3GEYJ272	2.7k	s
	R165	ERJ3GEYJ273	27k	S
	R166	ERJ3GEYJ822	8.2k	s
	R167	ERJ12YJ270	27	
	R178	ERJ2GEJ332	3.3k	S
	R301	ERJ6GEY0R00	0	s
	R311	ERJ2GEJ103	10k	s
	R312	ERJ2GEJ103	10k	S
	R321	ERJ2RKF1400	140	
	R322 R353	ERJ2RKF1000 ERJ2GEJ103	100 10k	S
	R358	ERJ2GEJ103	10k	S
	R359	ERJ2GEJ103	10k	S
	R360	ERJ2GEJ563	56k	s
	R371	ERJ12YJ1R0	1	
	R372	ERJ12YJ1R0	1	
	R383	ERJ3GEY0R00	0	S
	R474	ERJ2GEJ1R0	1	s
	R475	ERJ2GEJ1R0	1	s
	R501	D0GA563ZA006	56k	
	R502	ERJ2GEJ332	3.3k	s
	R504	ERJ2GEJ103	10k	s
	R505	ERJ2GEJ102	1k	S
	R506	ERJ2GEJ101	100	s
	R507	ERJ2GEJ104	100k	S
	R508	ERJ2GEJ100	10	s
	R511	ERJ2GEJ102	1k	S
	R515	ERJ2GEJ473	47k	S
	R516	ERJ2GEJ473	47k	S
	R517 R601	ERJ2GEJ473 ERJ2GEJ332	47k 3.3k	s
	R602	ERJ2GEJ552	560	S
	R603	ERJ2GEJ561	560	s
	R604	ERJ2GEJ561	560	s
	R605	ERJ2GEJ473	47k	s
	R606	ERJ2GEJ103	10k	s
	R611	ERJ2GEJ103	10k	S
	R612	ERJ2GEJ332	3.3k	s
	R613	ERJ2GEJ332	3.3k	s
	R652	ERJ2GEJ101	100	s
	R653	ERJ2GEJ101	100	s
	R654	ERJ2GEJ101	100	s
	R661	ERJ2GE0R00	0	S
	R662	ERJ2GEJ681	680	S
	R663	ERJ2GEJ681	680	s
	R664	ERJ2GEJ681	680	S

Safety	Ref.	Part No.	Part Name & Description	Remarks
	R665	ERJ2GEJ103	10k	s
	R666	ERJ2GE0R00	0	s
	R668	ERJ2GEJ561	560	S
	R671	ERJ2GEJ473	47k	s
	R672	ERJ2GEJ473	47k	S
	R673	ERJ2GEJ473	47k	s
	R702	ERJ2GEJ103	10k	S
	R703	ERJ2GEJ102	1k	s
	R721	ERJ2GEJ103	10k	s
	R731	ERJ2GEJ103	10k	S
	R733	ERJ2GEJ103	10k	S
	R734 R751	ERJ2GEJ103 ERJ2GEJ102	10k 1k	s
	R752	ERJ2GEJ102 ERJ2GEJ102	1k	S
	R781	ERJ2GE0R00	0	s
	R806	ERJ2GEJ221	220	s
	R807	ERJ2GEJ221	220	s
	R891	ERJ2GEJ221	220	S
	R892	ERJ2GEJ221	220	S
			(CAPACITORS)	
	C101	F1K2H681A008	680p	
	C102	F1K2H681A008	680p	
	C103	ECUV1C103KBV	0.01	
	C104	ECUV1C103KBV	0.01	
	C105	F1K2H681A008	680p	
	C106	F1K2H681A008	680p	
	C107	ECUV1C103KBV	0.01	
	C108	ECUV1C103KBV		
	C109	ECUE1H821KBQ	_	
	C110	ECUE1H821KBQ	_	
	C111	ECUE1A333KBQ		
	C112	ECUE1H100DCQ	_	
	C113	ECUE1A823KBQ		
	C125	ECUE1H100DCQ	_	
	C123	ECUE1H100DCQ ECUE1H100DCQ	-	
	C132	ECUV1H103KBV	_	
	C142	ECUV1H103KBV		
	C152	ECUE1C103KBQ		
	C161	EEE1HA100SP	10	
	C167	ECUV1H102KBV		
	C171	ECUV1C223KBV		
	C172	ECUE1H100DCQ	10p	
	C173	ECUE1A104KBQ	0.1	
	C184	ECUV1C105KBV	1	
	C186	ECUE1H100DCQ	10p	
	C306	F2A1C1010119	100	
	C311	ECUV1C105KBV	1	
	C312	ECUV1C105KBV		
	C321	ECUV1A105KBV		
	C341	F2A1A3310040		
	C342	ECUE1A104KBQ		
	C343	ECUE1H100DCQ		
	C351	ECUV1C105KBV		
	C460	ECUE1H100DCQ		
	C461	ECUE1H100DCQ	-	
	C472 C473	ECUE1H100DCQ	=	
	C474	ECUE1H100DCQ ECUE1H222KBQ		
	C475	ECUE1H222KBQ		
	C476	ECUE1H151JCQ		
-	C477	ECUE1H1310CQ ECUE1H100DCQ		1
-	C478	ECUE1H100DCQ	-	
	C479	ECUE1H151JCQ	=	
	C501	ECUE1A104KBQ		
	C502	ECUE0J105KBQ		
	C503	ECUE1H100DCQ		
	C504	ECUE1A104KBQ		
	C505	ECUE1A104KBQ		
	C506	ECUV1A225KBV		
	C507	ECUV1A105KBV	1	
	C508	ECUV1A105KBV	1	
	C509	ECUV0J225KBV	2.2	

KX-TG7622B/KX-TG7623B/KX-TGA410B			•		
Safety	Ref.	Part No.	Part Name & Description	Remarks	
	C511	ECUV1A105KBV	1		
	C513	ECUE1A104KBQ	0.1		
	C516	ECUE1A104KBQ	0.1		
	C517	ECUE1A104KBQ	0.1		
	C518	ECUE1A104KBQ	0.1		
	C519	ECUE1A104KBQ	0.1		
	C601	ECUE1A104KBQ	0.1		
	C603	ECUE1C103KBQ	0.01		
	C611	ECUE1A104KBQ	0.1		
	C661	ECUE1A104KBQ	0.1		
	C721	ECUE1A104KBQ	0.1		
	C751	ECUE1A104KBQ			
	C802	F1G1H1R8A480			
	C803	F1G1H1R5A480	•		
	C804	F1G1H1R8A480	_		
	C805	F1G1H2R4A480	_		
	C806	F1G1H2R4A480	_		
	C809	ECUE1H100DCQ	-	s	
	C810	F1G1H1R0A480	-		
	C811	ECUE1H100DCQ	-	s	
	C812	F1G1H1R0A480			
	C813	F1G1H1R0A480	-		
	C820	F1G1HR70A480	_		
	C822	ECUE1H100DCQ	_	s	
	C823	ECUE1H100DCQ	-	5	
	C825	ECUE1H101DCQ	·-	s	
	C826	ECUE1H100DCQ	-	s	
	C837	F1G1HR90A480		5	
	C841	F1G1H1R0A480	_		
			_		
	C842	F1G1H1R0A480	_		
	C844	F1G1H2R0A480	_		
	C850	G1C2N7Z00009			
	C851	F1G1H7R0A480	_		
	C853	F1G1H7R0A480	_	_	
	C855	ECUE1H100DCQ	-	s	
	C856	ECUE1H101JCQ	_		
	C857	ECUE1H100DCQ	_	S	
	C858	ECUE1H101JCQ			
	C863	F1G1H7R0A480	-		
	C864	F1G1H7R0A480			
	L		(OTHERS)		
	E1	L5DYBYY00021	LIQUID CRYSTAL DISPLAY (*2)		
	E2	PNHX1406Z	COVER, LCD		
	E3	PNHR1386Z	GUIDE, LCD	ABS-HB	
	P101	D4DAY220A022	THERMISTOR (POSISTOR)		
Λ	F301	K5H302Y00003	FUSE		
	X501	ној103500037	CRYSTAL OSCILLATOR (*1)		

16.5.1.3. Operational P.C. Board Parts

Safety	Ref.	Part No.	Part Name & Description	Remarks
	No.			
	PCB2	PNWP2TG7621H	OPERATIONAL P.C.BOARD	
			ASS'Y (RTL)	
			(LEDS)	
	LED901	LNJ237W82RA	LED	
	LED902	LNJ237W82RA	LED	
	LED905	LNJ237W82RA	LED	
	LED906	LNJ237W82RA	LED	
	LED907	LNJ237W82RA	LED	
	LED908	LNJ237W82RA	LED	
	LED911	LNJ237W82RA	LED	
	LED912	B3ABB0000331	LED	
	LED913	LNJ237W82RA	LED	
	LED914	B3ABB0000331	LED	
	LED915	LNJ237W82RA	LED	
	LED916	B3ABB0000331	LED	
			(RESISTORS)	
	R901	ERJ2GEJ181	180	S
	R902	ERJ2GEJ181	180	S
	R903	ERJ2GEJ181	180	S
	R904	ERJ2GEJ181	180	S

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
			(CAPACITORS)	
	C901	ECUV1C105KBV	1	
	C902	F1J1E105A197	1	
	C903	ECUE0J105KBQ	1	

16.5.2. Handset

16.5.2.1. Cabinet and Electrical Parts

Safety	Ref.	Part No.	Part Name & Description	Remarks
_	No.		_	
	101	PNGP1137Z1	PANEL, LCD	PMMA-HB
	102	PNYE1041Z	TAPE, DOUBLE SIDED	
	103	PNKM1191Z1	CABINET BODY	ABS-HB
	104	PNHR1391Z	OPTIC CONDUCTIVE PARTS, LED LENS	PS-HB
	105	PNGT5522Z	NAME PLATE	
	106	L0AD01A00026	RECEIVER	
	107	PNYE1029Z	SPACER, CUSHION LCD	
	108	PNBC1354Z1	BUTTON, NAVIGATOR KEY	ABS-HB
	109	PNJK1113Z	KEYBOARD SWITCH	
	110	PNJT1059Z	CHARGE TERMINAL (L)	
	111	PNJT1060Z	CHARGE TERMINAL (R)	
	112	PQHR11315Z	GUIDE, SPEAKER	ABS-HB
	113	L0AA02A00095	SPEAKER	
	114	PQHS10784Y	SPACER, SPEAKER NET	
	115	PNJC1018Z	BATTERY TERMINAL	
	116	PNKF1134Z1	CABINET COVER	ABS-HB
	117	PNKE1093Z1	COVER, RUBBERGRIP	
	118	PNQT2006Z	LABEL, ATTENTION	
	119	PNQT2065Z	LABEL, BATTERY	
	120	PNHS1079Z	SPACER, BATTERY	
	121	PNKK1053Z1	LID, BATTERY	ABS-HB
	122	PNYNTGA410BR	LID, BATTERY ASS'Y	ABS-HB

16.5.2.2. Main P.C. Board Parts

Note:

- (*1) Reconfirm the model No. written on the handset's name plate when replacing PCB100. Because the model No. of the optional handset may differ from the included handset.
- (*2) When replacing IC3 or X1, make the adjustment using PNZZTG7621M. Refer to **Handset** (P.64) of Things to Do after Replacing IC or X'tal.
- (*3) When replacing the handset LCD, See **How to Replace the Handset LCD** (P.54).

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB100	PNWPTGA410MR	MAIN P.C.BOARD ASS'Y	
			(RTL)	
			(ICs)	
	IC1	C2HBCY000081	IC	
	IC3	PNWITGA410MR	IC(EEPROM) (*2)	
			(TRANSISTORS)	
	Q2	B1ADCF000040	TRANSISTOR (SI)	
	Q3	B1ABGE000011	TRANSISTOR (SI)	
	Q4	B1ADCF000040	TRANSISTOR (SI)	
	Q5	B1GBCFYY0010	TRANSISTOR (SI)	
	Q6	B1GBCFYY0010	TRANSISTOR (SI)	
	Q9	B1ABCF000103	TRANSISTOR (SI)	S
	D13	B0BC4R3A0006	DIODE(SI)	
	D14	B0BC4R3A0006	DIODE(SI)	
	D21	B0BC4R3A0006	DIODE(SI)	
	D22	B0BC4R3A0006	DIODE(SI)	
	DA801	B0DDCD000001	DIODE(SI)	
			(LEDS)	
	LED1	B3ACB0000216	LED	
	LED2	B3ACB0000216	LED	
	LED3	B3ACB0000216	LED	

Safety	Ref. No.	Part No.	Part Name & Description	Remark
	LED4	B3ACB0000216	LED	
	LED5	B3ACB0000216	LED	
	LED6	B3ACB0000216		
	LED7	B3ACB0000216		
	LED8	B3ACB0000216		
	LED9	B3ACB0000216		
	LED12	B3ACB0000216	LED	
			(COILS)	
	C812	PQLQR4C8N2J	COIL	S
	L13	G1CR18J00004	COIL	
			(RESISTOR ARRAYS)	
	RA1	EXB28V221JX	RESISTOR ARRAY	
	RA2		RESISTOR ARRAY	s
	RA3	D1H433120001	RESISTOR ARRAY	
	RA4	D1H433220001	RESISTOR ARRAY	
	RA5	EXB28V332JX	RESISTOR ARRAY	
			(IC FILTER)	
	L29	J0JDC0000045	IC FILTER	
			(RESISTORS)	
	P2	ED.TOCE TOCO		9
	R2	ERJ2GEJ303	30k	S
	R3	ERJ2GEJ152	1.5k	S
	R4	ERJ2GEJ473	47k	S
	R6	ERJ2GEJ103	10k	S
	R7	ERJ2GEJ104	100k	s
	R8	ERJ8GEYJ3R3	3.3	s
	R9	ERJ2GEJ303	30k	s
		-		
	R10	ERJ2GEJ100	10	S
	R21	ERJ2GEJ104	100k	S
	R23	ERJ2GEJ100	10	S
	R24	ERJ2GEJ391	390	S
	R27	ERJ2GEJ222	2.2k	s
	R28	ERJ2GEJ222	2.2k	s
	R31	ERJ2GEJ104	100k	s
	R33	ERJ2GEJ104	100k	S
	R34	ERJ2GEJ391	390	S
	R35	ERJ2GEJ104	100k	S
	R45	ERJ6RSJR10V	0.1	
	R64	ERJ2GEJ222	2.2k	s
	R66	ERJ2GEJ103	10k	s
	R67	ERJ2GEJ103	10k	S
	R68	ERJ2GEJ103	10k	S
	R69	ERJ2GEJ103	10k	S
	R73	ERJ2GEJ330	33	S
	R74	ERJ2GEJ330	33	S
	R561	ERJ2GEJ221	220	s
	R563	ERJ2GE0R00	0	s
	R806	ERJ2GEJ471	470	s
	R807			
		ERJ2GEJ471	470	S
	L9	ERJ2GE0R00	0	S
			(CAPACITORS)	<u></u>
	C1	EEE0JA221WP	220	
	C2	EEE0JA221WP	220	
	C4	ECUE1H390JCQ	39p	1
	C5	ECUE1A104KBQ	_	1
	C8	ECUE1H100DCQ		
	C9	ECUE1H120JCQ	=	
	C10		220	
	C11	ECUE1A104KBQ	0.1	L
	C12	PQCUV0J106KB	10	
	C13	ECUE1A104KBQ	0.1	
	C15	ECUE1H390JCQ		
	C17	ECUE1H100DCQ		
			=	
	C18	ECUE1H100DCQ	_	ļ
	C19	ECUE1H102KBQ		
	C20	ECJ1VB0G106M	10	S
	C21	ECUV1A105KBV	1	
	C22	ECUE1A104KBQ	0.1	
	C23	ECUE1A104KBQ		1
	C24	ECUE0J105KBQ		
				-
	C25	ECUV1A225KBV		<u> </u>
	C26	ECJ1VB0G106M	10	s
	C29	ECUV1A105KBV	1	
	C30	ECJ1VB0G106M	10	s

			KX-TG7622B/KX-TG7623B/KX	-TGA410B
Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	C31	ECUE0J105KBQ	1	
	C32	ECUE0J105KBQ	1	
	C33	ECUE1A104KBQ	0.1	
	C34	ECUE1H390JCQ	39p	
	C36	ECUE1A104KBQ	0.1	
	C37	ECJ1VB0G106M	10	S
	C40	ECUE1A104KBQ	0.1	
	C41	ECUE1A104KBQ	0.1	
	C43	ECUE1A104KBQ	0.1	
	C44	ECUE0J105KBQ	1	
	C45	ECUE1A104KBQ	0.1	
	C46	ECUE1H100DCQ	10p	S
	C51	ECJ1VB0G106M	10	S
	C72	ECUE1H100DCQ	10p	
	C73	ECUE1H100DCQ	10p	
	C78	ECUE1H390JCQ	39p	
	C79	ECUE1H101JCQ	100p	
	C80	ECUE1H390JCQ	39p	
	C81	ECUE1H101JCQ	100p	
	C86	F1J0J2260002	22	
	C96	ECUE1H100DCQ	10p	
	C97	ECUE1H100DCQ	10p	
	C127	ECUE1H102KBQ	0.001	
	C150	ECUE1A104KBQ	0.1	
	C152	ECUE1H102KBQ	0.001	
	C172	ECUE1A104KBQ	0.1	
	C188	ECUE0J105KBQ	1	
	C504	ECUV1C105KBV	1	
	C505	ECUE0J105KBQ	1	
	C805	F1G1H2R4A480	2.4p	
	C806	F1G1H2R4A480	2.4p	
	C810	F1G1H2R5A480	2.5p	
	C811	ECUE1H101JCQ	100p	S
	C813	F1G1H1R6A480	1.6p	
	C820	F1G1H1R8A480	1.8p	
	C822	ECUE1H100DCQ	10p	S
	C825	ECUE1H100DCQ	10p	S
	C826	ECUE1H100DCQ	10p	S
	C859	F1G1H2R0A480	2p	
	C863	F1G1H1R8A480	1.8p	
	C895	F1G1H1R3A480	1.3p	
	C896	F1G1H1R8A480	1.8p	
	C897	F1G1H240A557	24p	
	L809	F1G1H1R0A480	1p	
	MIC100	L0CBAY000053	MICROPHONE	
	E101	L5DYBYY00001	LIQUID CRYSTAL DISPLAY	
	E102	PNHR1114Z	(*3) TRANSPARENT PLATE, LCD	PMMA-HB
	E102	PNHR1114Z PNHR1392Z	GUIDE, LCD	ABS-HB
	E103			1110 - HD
		PNHX1136Z	COVER, LCD	
	E105	PNLA1049Z	ANTENNA	ABC. UD
	E106	PNVE1011Z	BATTERY TERMINAL	ABS-HB
A	E107 F1	PQHG10729Z K5H252Y00002	RUBBER PARTS, RECEIVER	
<u> </u>				_
	X1	H00138200003	CRYSTAL OSCILLATOR (*1)	S

16.5.3. Charger Unit

16.5.3.1. Cabinet and Electrical Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	200	PNLC1018ZB	CHARGER UNIT ASS'Y without NAME PLATE (RTL)	
	200-1	PNKM1204Z1	CABINET BODY	PS-HB
	200-2	PNJT1066Z	CHARGE TERMINAL	
	200-3	PNKF1150Z1	CABINET COVER	PS-HB
	200-4	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	
	201	PNGT5533Z	NAME PLATE	

16.5.3.2. Main P.C. Board Parts

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	PCB200	PNWPTGA660CH	MAIN P.C.BOARD ASS'Y (RTL)	
			(JACK)	
	J1	K2ECYB000001	JACK	s
			(RESISTOR)	
	R1	ERX2SJ6R8	6.8	
			(FUSE)	
⚠	F1	K5H302Y00003	FUSE	

16.5.4. Accessories and Packing Materials Note:

(*1) You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

16.5.4.1. KX-TG7622B

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
Δ	A1	PNLV226Z	AC ADAPTOR	
	A2	PQJA10075Z	CORD, TELEPHONE	
	A3	PNQX3168Y	INSTRUCTION BOOK (*1)	
	A4	PNQW2594Z	LEAFLET, QUICK GUIDE	
	A5	PQKL10088Z1	STAND, WALL MOUNT	
	P1	PNPK3280001Z	GIFT BOX	
	P2	PNPD1466Z	CUSHION	

16.5.4.2. KX-TG7623B

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
⚠	A101	PNLV226Z	AC ADAPTOR	
	A102	PQJA10075Z	CORD, TELEPHONE	
	A103	PNQX3168Y	INSTRUCTION BOOK (*1)	
	A104	PNQW2594Z	LEAFLET, QUICK GUIDE	
	A105	PQKL10088Z1	STAND, WALL MOUNT	
	P101	PNPK3281001Z	GIFT BOX	
	P102	PNPD1467Z	CUSHION	

16.5.4.3. KX-TGA410B

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
Λ	A201	PNLV226Z	AC ADAPTOR	
	A202	PNQX3136Z	INSTRUCTION BOOK (*1)	
	P201	PNPK3285001Z	GIFT BOX	

16.5.5. Screws

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
	A	XTB26+8GFJ	TAPPING SCREW	
	В	XTB2+8GFJ	TAPPING SCREW	

16.5.6. Fixtures and Tools

Note:

- (*1) See Equipment Required (P.56), and The Setting Method of JIG (P.56)
- (*2) When replacing the Handset LCD, See **How to** Replace the Handset LCD (P.54)

Safety	Ref. No.	Part No.	Part Name & Description	Remarks
		PQZZ1CD300E	JIG CABLE (*1)	
		PNZZTG7621M	BATCH FILE CD-ROM (*1)	

S	Safety	Ref. No.	Part No.	Part Name & Description	Remarks
			PQZZ430PIR	TIP OF SOLDERING IRON (*2)	
			PQZZ430PRB	RUBBER OF SOLDERING IRON (*2)	

T.I/N KXTG7622B KXTG7623B KXTGA410B